

### **DATA SHEET**

# GEN series GN840B, GN1640B Universal/Sensor ISO 500 kS/s Input Card

### **SPECIAL FEATURES**

- Ranges ± 0.2 mV/V up to ± 500 mV/V
- Quarter/Half/Full bridge
- 6 wire configuration
- Quick sensor test (shunt)
- Voltage excited sensors
- IEPE sensors
- IEEE 1451.4 TEDS class 1, 2 and 3
- Piezoelectric/Charge sensors
- 4 to 20 mA sensors
- Pt10, Pt100, Pt500, Pt1000 and Pt2000 (3 and 4 wire RTD)
- Thermocouples K, J, T, B, E, N, R, S, C
- Resistor value
- 33 V RMS Isolation
- Analog/digital anti-alias filters
- 500 kS/s sample rate/channel
- 24 bit ADC resolution



### **GN840B/GN1640B FUNCTIONS and BENEFITS**

The Universal Sensor Card supports quarter, half and full bridges with built-in 350  $\Omega$  and 120  $\Omega$  quarter bridge completion resistors. The shunt resistor offers a quick test of the sensor.

In IEPE mode the card supports open and shorted wire detection and TEDS sensor setup.

Thermocouples, piezoelectric, RTD and 4 to 20 mA sensors are all directly supported. All sensor types connect to the input without external adapters. Measurement ranges starting at  $\pm$  0.2 mV/V up to  $\pm$  500 mV/V and sensor impedance from 17  $\Omega$  up to 10 k $\Omega$  support virtually any sensor.

Superior, best in class anti-alias protection is achieved by a unique, multi stage approach. The first stage the Sigma Delta converter with built in anti-aliasing filter creates an alias free digital data stream at constant rate of 500 kS/s.

The second stage feeds the 500 kS/s data stream into a user selectable digital filter, to reduce the signal to the desired maximum bandwidth. The digital filter supports both 11 or 12 orders as well as Bessel/Butterworth or Elliptic filter characteristics. The third stage decimates the 500 kS/s filtered signal to the desired sample rate.

The digital filter before decimation guarantees a superior phase match, ultra-low noise and alias free result.

The optional real-time formula database calculators solve almost any mathematical challenge. Real-time digital cycle detection enables periodic results like PeakToPeak. Real-time channel to channel sample math can reverse calculate crosstalk interdependencies within a three axes force sensor. Calculated results can be used to trigger the recording or signal alarms to the external world.

804170\_05\_E00\_00 31/10/2023

## GN840B/GN1640B

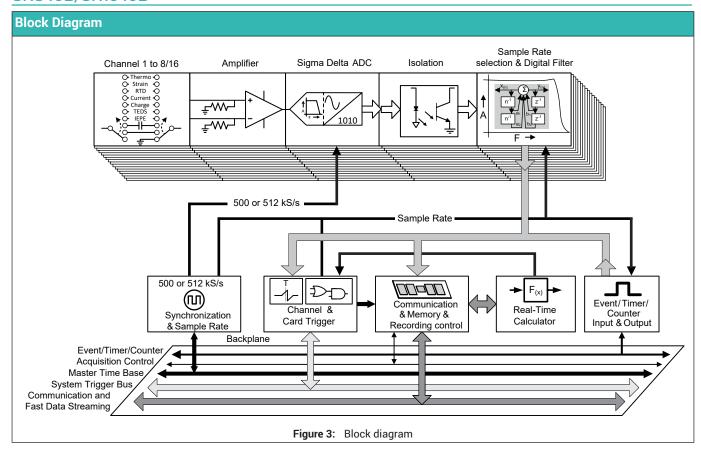
Capabilities Overview	
Model	GN840B, GN1640B
Maximum sample rate per channel	500 kS/s
Memory per card	2 GB
Analog channels	8 for GN840B and 16 for GN1640B
Anti-alias filters	Fixed bandwidth analog AA-filter combined with sample rate tracking digital AA-filter
ADC resolution	24 bit
Isolation	33 V RMS, ± 70 V DC, channel to channel and channel to chassis
Input type	Analog isolated balanced differential
Passive voltage/current probes	Active single-ended and differential probes
Sensors	Quarter, half and full strain gauges/ bridges. Force, pressure, MEMS-type accelerometers and potentiometric displacement transducers. IEPE, piezoelectric, Pt10, Pt100, Pt500, Pt1000, Pt2000, 420 mA sensors Thermocouples types K, J, T, B, E, N, R, S and C
TEDS	Class 1, 2 and Class 3 (pending IEEE acceptance)
Real-time formula database calculators (option)	Extensive set of user programmable math routines
Digital Event/Timer/Counter	Supported; 16 digital events and 2 Timer/Counter channels
Standard data streaming (CPCI up to 200 MB/s)	Not supported
Fast data streaming (PCIe up to 1 GB/s)	Supported
Slot width	1 for GN840B 2 for GN1640B

Mainframe Support						
	GEN2tB	GEN4tB	GEN7tA / GEN7tB	GEN17tA / GEN17tB	GEN3iA	GEN7iA / GEN7iB
GN840B/GN1640B			Y	es		
GEN DAQ API		Ye	es		Ye	s <sup>(1)</sup>
EtherCAT®	No		Yes		N	lo
CAN/CAN FD		Ye	es		N	lo

<sup>(1)</sup> Close Perception to enable GEN DAQ API access.

Supported Analog Sen	sors and Probes	
Amplifier mode	Supported analog sensors and probes	Features, Cabling and Accessories
Basic voltage	<ul> <li>Electrical voltages single-ended and differential</li> <li>Active single-ended probes</li> <li>Active differential probes</li> </ul>	± 1 mV up to ± 10.0 V     Isolated voltage input     14 pin ODU connector     DIN rail mounted dual BNC breakout 1-G090     ODU to BNC cable 1-KAB433-2
Basic sensor	<ul> <li>(Damped) Piezoresistive accelerometers</li> <li>Potentiometric displacement transducers</li> <li>Voltage output sensors using DC voltage excitation like Force, Pressure, MEMS-type and Kulite sensors</li> </ul>	$ \begin{array}{ll} \bullet & \pm 0.2 \text{ mV/V up to} \pm 500 \text{ mV/V} \\ \bullet & \text{Basic sensor mode is a simplified bridge GUI} \\ \bullet & \text{Sensor impedance from } 17 \ \Omega \text{ to } 10 \ \text{k}\Omega \\ \bullet & \pm 0.5 \ \text{V to} \pm 5.0 \ \text{V DC sensor supply voltage} \\ \bullet & \text{DIN rail mounted push-pull breakout } 1\text{-G088} \\ \bullet & \text{Breakout cable with open ends } 1\text{-KAB183-x} \\ \end{array} $
Bridge	Quarter, half and full strain gauges/ bridges     Strain gauge based sensors: load cells, force transducers, torque transducers and pressure transducers	<ul> <li>± 0.2 mV/V up to ± 500 mV/V</li> <li>No external support tools required</li> <li>Bipolar ± 0.5 V to ± 5.0 V DC excitation voltage</li> <li>2 * 10 kΩ built in half bridge completion resistors</li> <li>120 Ω and 350 Ω built in quarter bridge completion</li> <li>3 wire quarter bridge support</li> <li>Built in 100 kΩ shunt resistor</li> <li>DIN rail mounted push-pull breakout: 1-G088</li> <li>Breakout cable with open ends 1-KAB183-x</li> </ul>
Charge	Piezo-electric sensors	<ul> <li>± 1 nC up to ± 10 μC</li> <li>AC input coupled</li> <li>ODU to BNC cable 1-KAB433-2</li> </ul>
IEPE	IEPE based sensors like accelerometers, microphones and pressure transducers     ICP® Accelerometers	± 1 mV up to, ± 10.0 V  IEPE current: 2, 4, 6 or 8 mA @ ≥ 23 V  TEDS class I  Sensor connected, open or shorted diagnostics  DIN rail mounted dual BNC breakout : 1-G090  ODU to BNC cable 1-KAB433-2
Current loop	Electrical current 4 to 20 mA     Sensors with to 20 mA output	Built in burden resistor     DIN rail mounted dual BNC breakout : 1-G090     ODU to BNC cable 1-KAB433-2
Thermocouple	Thermocouples types K, J, T, B, E, N, R, S and C	<ul> <li>Digital cold junction compensation</li> <li>DIN rail mounted cold junction plug: 1-G089</li> <li>Thermocouple bandwidth up to 10 kHz</li> </ul>
Resistance thermometers	<ul> <li>Resistive Temperature Detectors (RTD)</li> <li>Pt10, Pt100, Pt500, Pt1000 and Pt2000</li> </ul>	<ul> <li>3 and 4 wire support</li> <li>DIN rail mounted push-pull breakout: 1-G088</li> <li>Breakout cable with open ends 1-KAB183-x</li> </ul>

Supported Digital Sensors (TTL Level Input)					
Timer counter Input type	Supported digital sensors	Features			
Signal Direction 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	<ul> <li>AngleTorque sensors</li> <li>Frequency / RPM</li> <li>Count/position</li> </ul>	<ul> <li>Count frequency up to 5 MHz</li> <li>Input signal minimum width setting</li> <li>Several reset options</li> <li>RT-FDB can add a calculated Frequency/RPM channel based on the angle measurement</li> </ul>			
Signal  Direction  1 2 3 4 3 2 1  Wheel rotates clock wise  Wheel rotates counter clock wise  Figure 2: ABZ Incremental Encoder (Quadrature)	<ul> <li>AngleTorque sensors</li> <li>Frequency / RPM</li> <li>Count/position</li> </ul>	<ul> <li>Count frequency up to 2 MHz</li> <li>Single, dual and quad precision count Input signal minimum width setting</li> <li>Transition tracking to avoid count drift</li> <li>Several reset options</li> <li>RT-FDB can add a calculated Frequency/RPM channel based on the angle measurement</li> </ul>			



### Specifications and measurement uncertainty

Specifications are established using 23 °C environmental temperature.

For measurement uncertainty improvements, the system could be readjusted at a specific environmental temperature to minimize the impact of temperature drift.

Any analog amplifier error source follows the =  $\mathbf{a}x + \mathbf{b}$  curve.

- a % of reading error, represents the linear increasing error due to the increase of the input voltage: often referred to as gain error.
- **b** % of range error, represents the error when measuring 0 V; often referred to as offset error.

For measurement uncertainty these errors can be considered independent error sources.

Noise is not a separate error source outside of the standard specification.

Noise specifications are added separately in case you need dynamic accuracy on sample by sample level.

Only for sample by sample measurement uncertainty add the RMS noise error.

For e.g. power accuracy, the RMS noise error is already included in the power specifications.

Pass/Fail limits are rectangular distributed specifications, therefore measurement uncertainty is 0.58 \* specified value.

### Adding/removing or swapping cards

The specifications listed are valid for cards that have been calibrated and are used in the same mainframe, mainframe configuration and slots as they were at the time of calibration.

If cards are added, removed or relocated the thermal conditions of the card will change, resulting in additional thermal drift errors. The maximum expected error can be up to two times the specified Reading and Range error as well as 10 dB reduced common mode rejection. Recalibration after configuration changes is therefore highly recommended.

4

Analog Input Section			
Input type	Analog isolated balanced differential		
Impedance	2 * 10 MΩ ± 1% // 45 pF ± 10% (Differential)		
Input coupling	Single-ended positive, single-ended negative and differential		
Signal input coupling			
Coupling modes	AC, DC, GND		
AC coupling frequency	1.6 Hz ± 10%; - 3 dB		

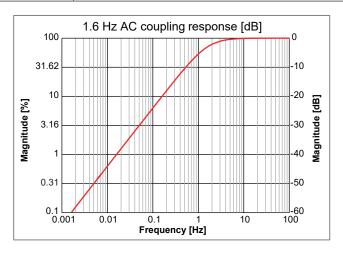
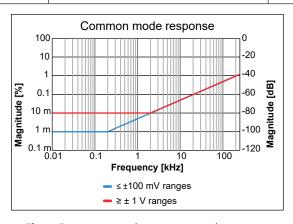


Figure 4: Representative AC coupling response

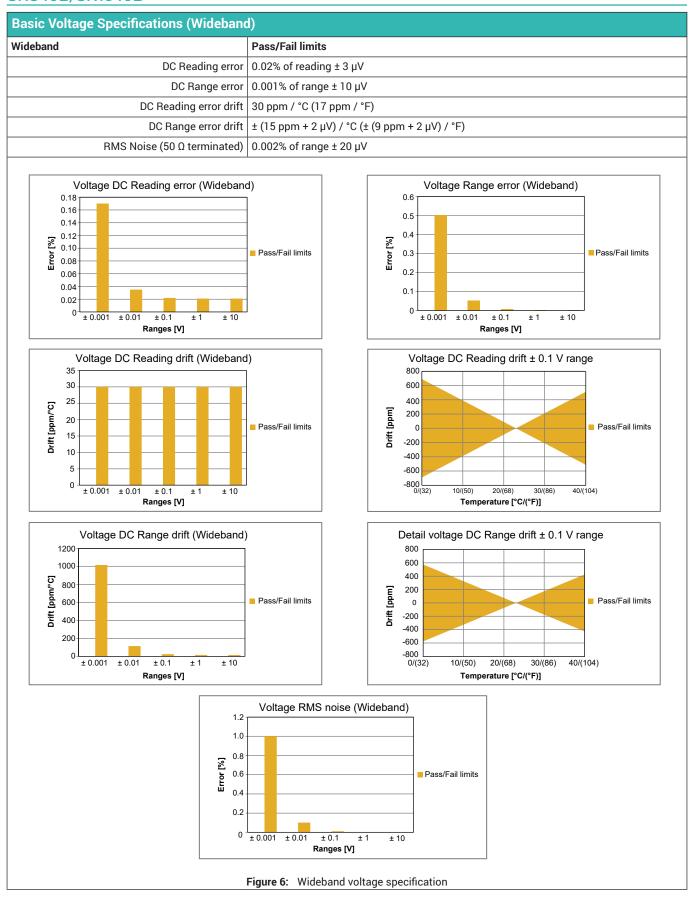
Ranges	± 1 mV, ± 10 mV, ± 0.1 V, ± 1.0 V, ± 10.0 V
Offset	± 50% in 1000 steps (0.1%). For all ranges except ± 10 V range (20 V span)

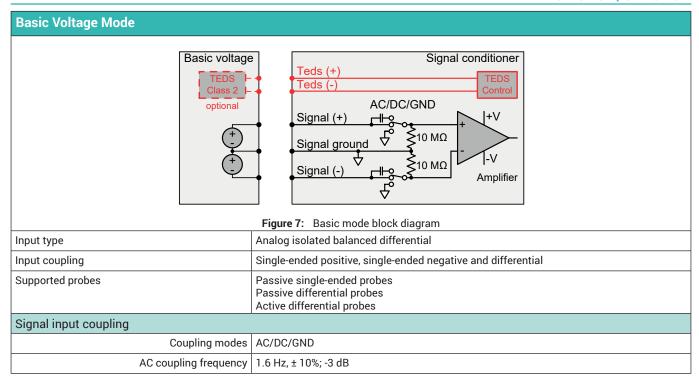
Common mode (referred to system ground/earth)				
Ranges	Less than or equal to ± 100m V	Larger than or equal to ± 1 V		
Rejection (CMR)	> 100 dB @ 80 Hz (105 dB typical)	> 80 dB @ 80 Hz (95 dB typical)		
Maximum common mode voltage	7 V RMS	7 V RMS		

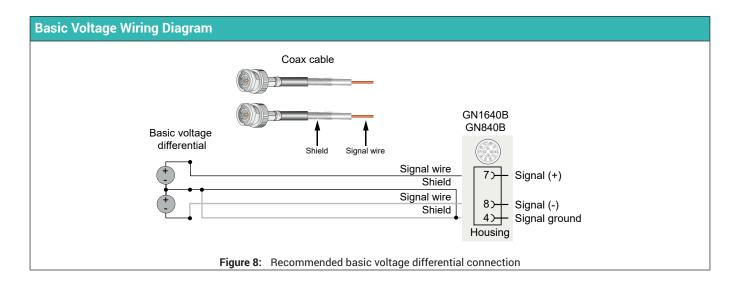


**Figure 5:** Representative common mode response

Input overload protection			
3 .	The activation of the overvoltage protection system results in a reduced input impedance. The overvoltage protection is not active for as long as the input voltage is between -12 V and +15 V in respect to channel ground.		
Maximum nondestructive voltage	± 25 V DC		







#### **Bridge Mode** Bridge sensor Signal conditioner Teds (+) **TEDS** Teds (-) Control Sense (-) Excitation (-) Excitation Sense (+) Excitation (+) 350 Ω - ¼ bridge 120 Ω - 1/4 bridge ½ bridge Signal (+) Signal ground 10 MΩ Signal (-) Amplifier L<sub>M</sub>Int shunt Shunt External shunt Figure 9: Bridge mode block diagram Quarter, half and full strain gauges/ bridges. Supported sensors Strain gauge based sensors: load cells, force transducers, torque transducers and pressure transducers. Quarter bridge connection Three wire support; the third wire keeps the measurement wire current free eliminating wire resistance errors through the measurement wire Built in quarter bridge completion resistor 120 $\Omega$ and 350 $\Omega$ , 0.1% 2 ppm/°C, wired to separate connector pin Built in half bridge completion resistors 2 times 10 kΩ, 0.05% 2 ppm/°C tracking Bridge excitation modes Constant voltage TEDS support Class 2 and 3 (no software support at release date) Constant voltage excitation Excitation voltage inaccuracy ± 0.25% Bipolar excitation voltage ± 0.5 V @ 30 mA ± 1 V @ 30 mA ± 2 V @ 30 mA ± 5 V @ 30 mA Transducer impedance $16.7 \Omega$ to $10 k\Omega$ 33.3 $\Omega$ to 10 k $\Omega$ 66.7 $\Omega$ to 10 k $\Omega$ 166.7 $\Omega$ to 10 $k\Omega$ ± 2 mV/V ± 1 mV/V ± 0.5 mV/V ± 0.2 mV/V Measuring ranges (mV/Volt excitation)(1) ± 20 mV/V ± 10 mV/V ± 5 mV/V ± 2 mV/V ± 200 mV/V ± 100 mV/V ± 50 mV/V ± 20 mV/V ± 500 mV/V ± 200 mV/V Excitation voltage sense 2 separate connector pins available, wiring required (no internal bypass) Maximum cable length 100 m (328 ft), cable impedance $\leq$ 0.2 $\Omega$ /m (0.06 $\Omega$ / ft) Bridge balance Bridge in-balance measured and software compensated by means of auto zero Operation principal Parallel execution of auto zero on all channels on multiple cards reducing zero time Auto zero significantly Bridge shunt (Sensor quick test) Bridge shunt resistor selection Software selectable 2 sources 1 built-in shunt resistors, or external shunt Bridge shunt method Software selectable to positive or negative excitation voltage External shunt 1 separate connector pin to wire shunt out to sensor connection points Built-in shunt resistor Metal foil Type Shunt resistor 100 kΩ, 0.1% 5 ppm/°C

8

<sup>(1)</sup> Used amplifier range = mV/V range \* Excitation voltage level

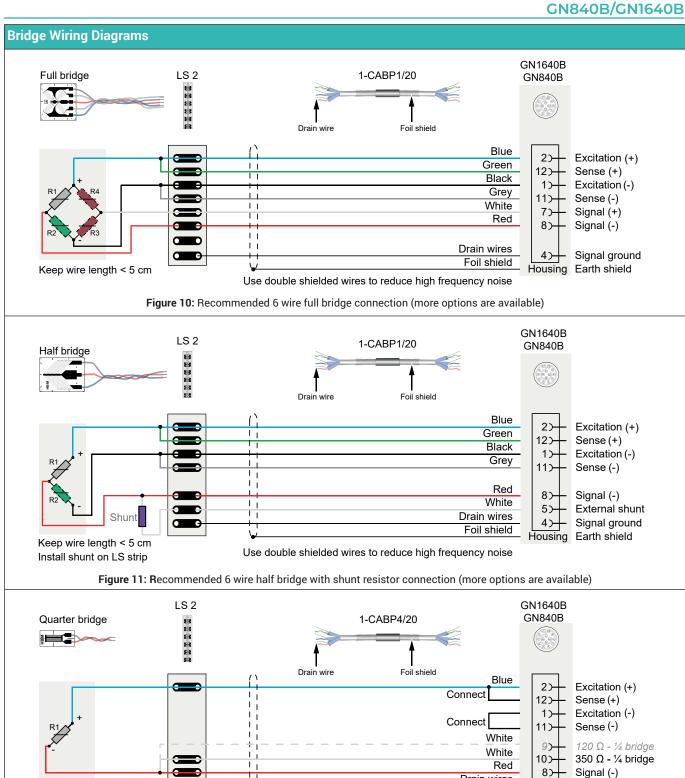


Figure 12: Recommended 3 wire 350 Ω quarter bridge connection (more options are available)

Use double shielded wires to reduce high frequency noise For 120  $\Omega$  - 1/4 bridge usage connect the white wire to pin 9

in stead of pin 10

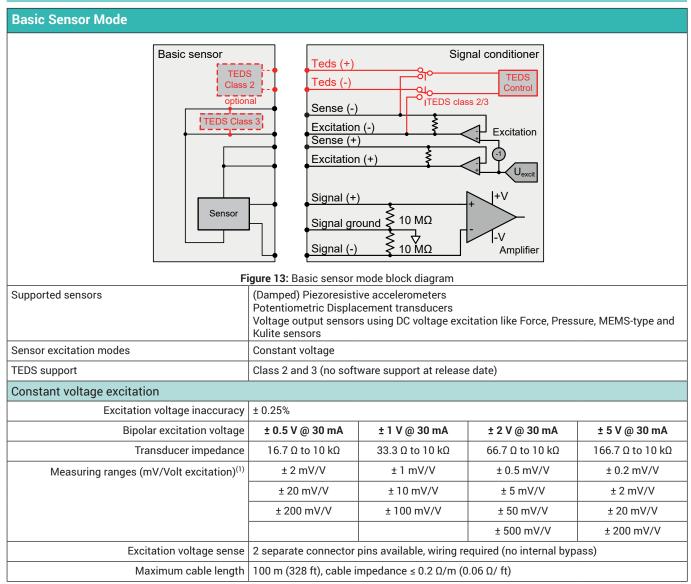
Keep wire length < 5 cm

Drain wires

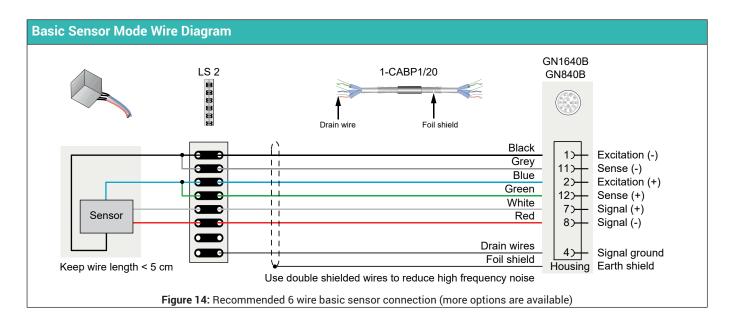
Foil shield

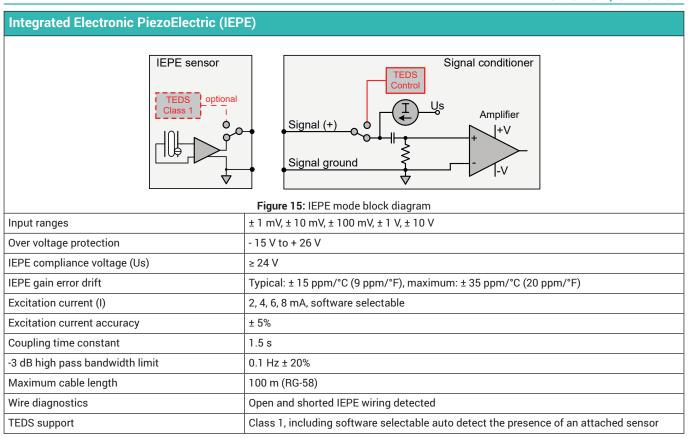
Signal ground

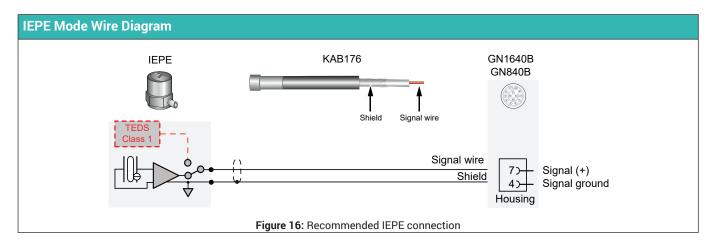
Housing Earth shield

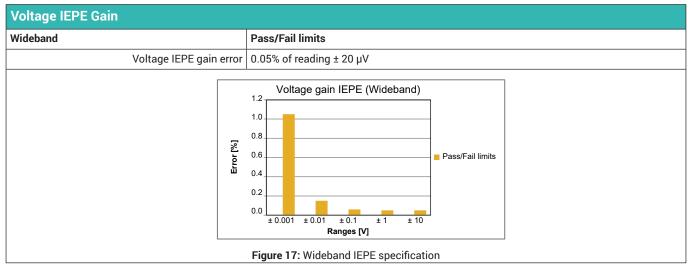


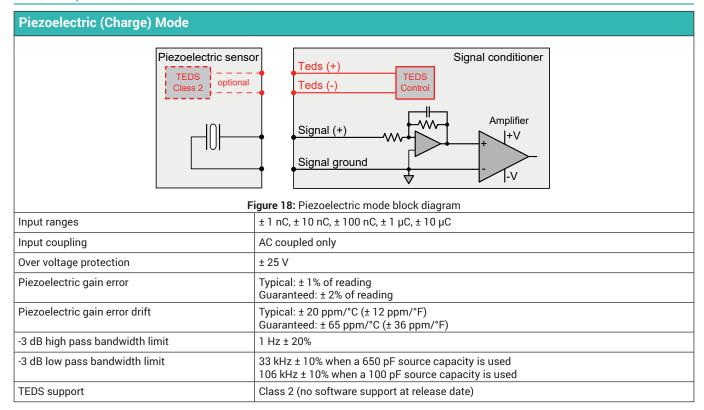
(1) Used amplifier range = mV/V range \* Excitation voltage level

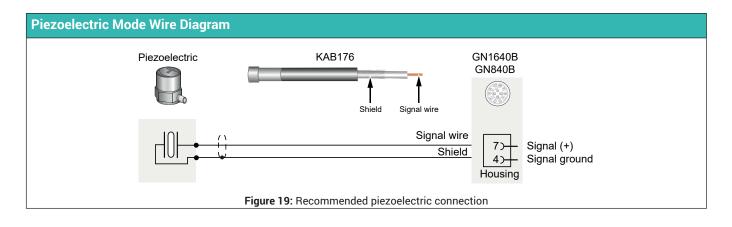


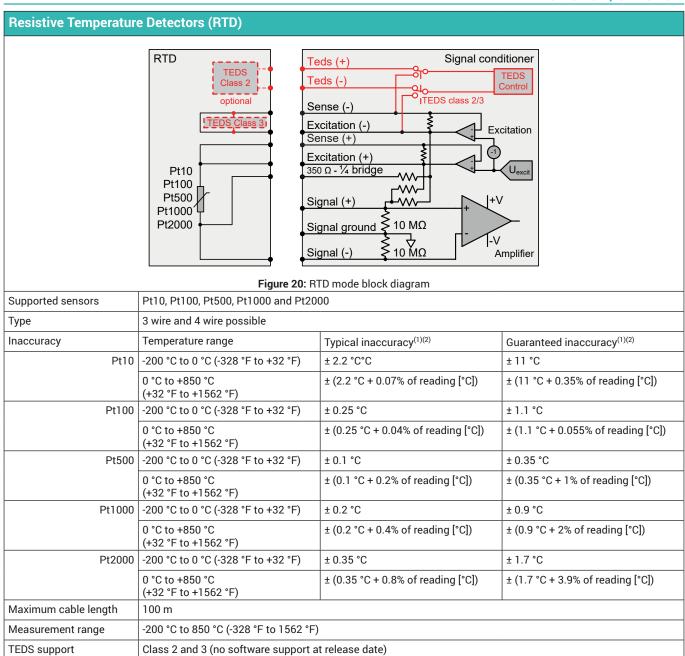












- (1) Used amplifier range = mV/V range \* Excitation voltage level
- (2) Measured with Meatest M632 precision resistance decade.

### **Resistance Mode**

Resistance measurement works as a bridge measurement.

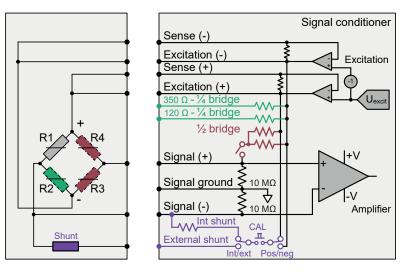


Figure 21: Resistance measurement using bridge setup

rigure 21. Resistance measurement using bridge setup				
Supported sensors	Resistor			
Quarter bridge connection	Four wire support; the third wire keeps the measurement wire current free eliminating wire resistance errors through the measurement wire, the fourth wire is used to sense the excitation voltage			
Built in quarter bridge completion resistor	120 $\Omega$ and 350 $\Omega$ , 0.1% 2 ppm/°C, wired to separate connector pin			
Built in half bridge completion resistors	2 times 10 kΩ, 0.05% 2 ppm/°C tracking			
Bridge excitation modes	Constant voltage			
Constant voltage excitation				
Selectable excitation voltage	Bipolar ± 0.5 V DC to ± 5.0 V DC, maximum 30 mA			
Excitation voltage in-accuracy ± 0.25%				
Excitation voltage sense 2 separate connector pins available, wiring required (no internal bypass)				

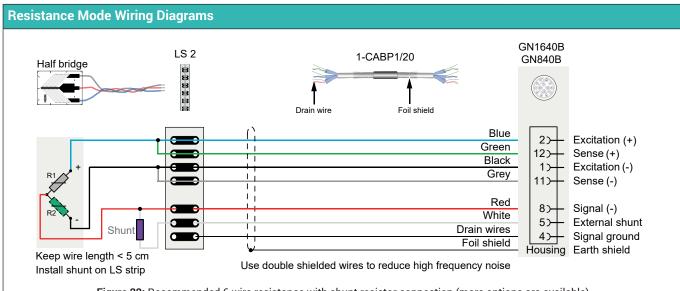


Figure 22: Recommended 6 wire resistance with shunt resistor connection (more options are available)

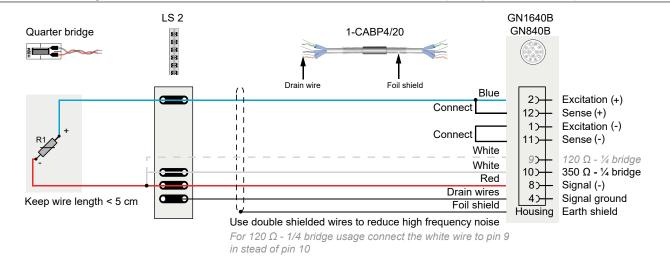
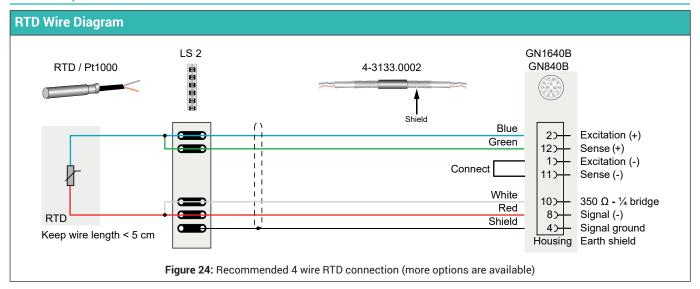


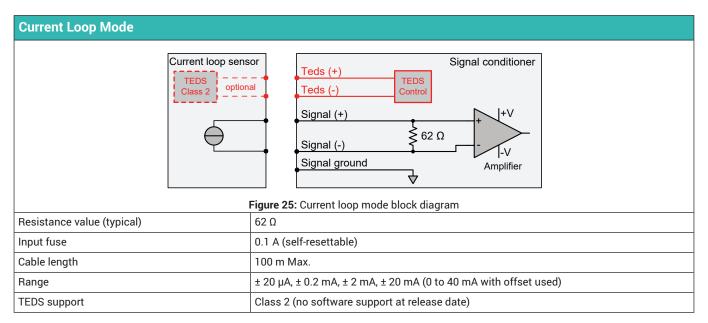
Figure 23: Recommended 3 wire resistance connection (more options are available)

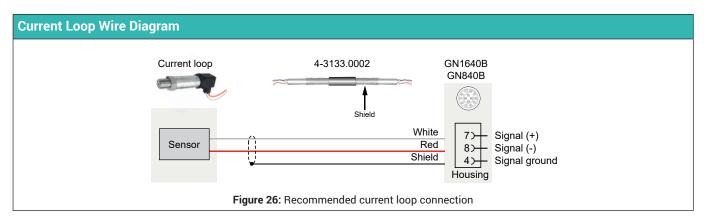
Accuracy			
Mode	Completion resistor	Range R1	Typical <sup>(1)(2)(3)</sup>
Half bridge	1000 Ω	250 Ω to 550 Ω 550 Ω to 3050 Ω 3050 Ω to 3350 Ω	0.25% 0.10% 0.25%
Quarter bridge	350 Ω	90 Ω to 160 Ω 160 Ω to 1060 Ω 1060 Ω to 1170 Ω	0.25% 0.10% 0.25%
	120 Ω	45 Ω to 70 Ω 70 Ω to 250 Ω 250 Ω to 420 Ω	0.25% 0.10% 0.25%

- (1) Completion resistor 1000  $\Omega$  and 350  $\Omega$  measured with excitation voltages  $\pm$  500 mV,  $\pm$  1 V,  $\pm$  2.5 V and  $\pm$  5V.
- (2) Completion resistor 120  $\Omega$  measured with excitation voltages  $\pm$  500 mV,  $\pm$  1 V, and  $\pm$  2.5V.
- (3) Filter setting Bessel Low pass 5 Hz

Measured with Meatest M632 precision resistance decade.







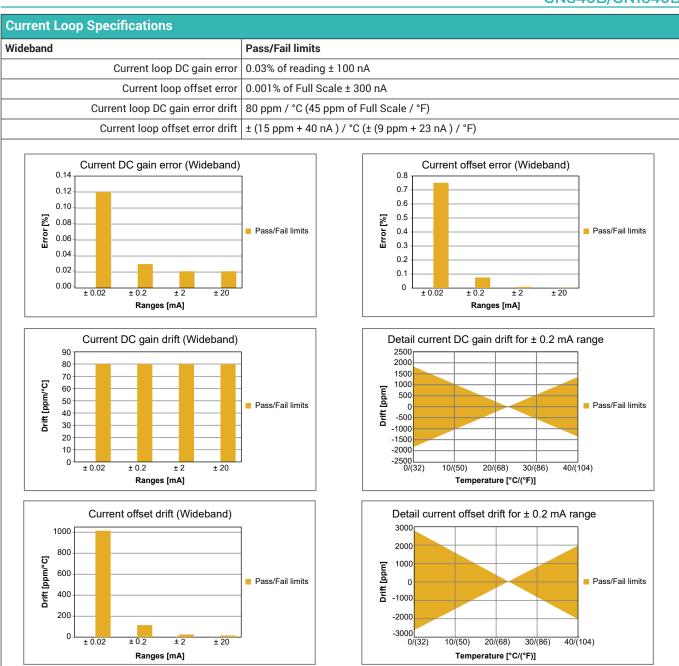
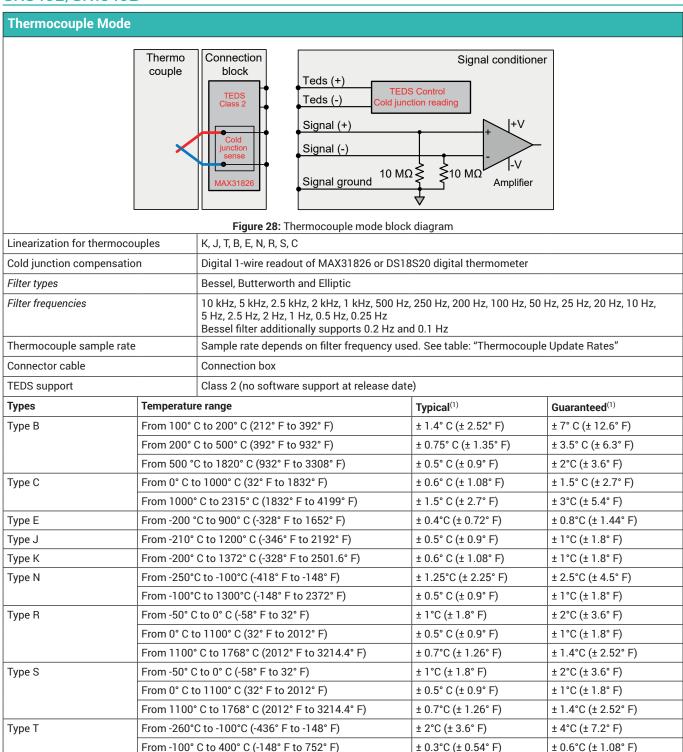
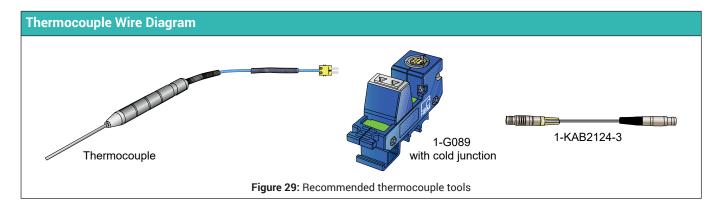


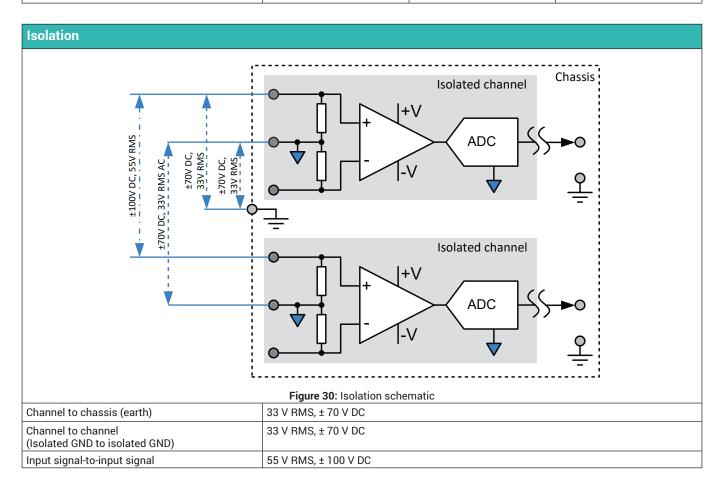
Figure 27: Wideband current loop specification



(1) Measured using Bessel filter at 5 Hz bandwidth.



Thermocouple Update Rates			
Limited update rate		e	
Filter cut off	1 S/s to 500 S/s	1 kS/s to 5 kS/s	5 kS/s to 500 kS/s
0.25 Hz	500 Hz	500 Hz	500 Hz
0.5 Hz	500 Hz	500 Hz	500 Hz
1 Hz	500 Hz	5 kHz	5 kHz
2 Hz	500 Hz	5 kHz	5 kHz
2.5 Hz	500 Hz	5 kHz	5 kHz
5 Hz	500 Hz	5 kHz	5 kHz
10 Hz	500 Hz	5 kHz	50 kHz
20 Hz	500 Hz	5 kHz	50 kHz
25 Hz	500 Hz	5 kHz	50 kHz
50 Hz	500 Hz	5 kHz	50 kHz
100 Hz	500 Hz	5 kHz	500 kHz
200 Hz	-	5 kHz	500 kHz
250 Hz	-	5 kHz	500 kHz
500Hz	-	5 kHz	500 kHz
1000 Hz	-	5 kHz	500 kHz
2000 Hz	-	-	500 kHz
2500 Hz	-	-	500 kHz
5000 Hz	-	-	500 kHz
10000 Hz	-	-	500 kHz



## GN840B/GN1640B

GN1640B/GN840B Connector and Pinning				
Mating connector	HBM 1-CON-P1007; ODU SX2B0C-P14MFG0-0001 (male)			
Connectors	ODU GX2B0C-P14QF00-0002 (female)			
	GN1640B/GN840B	KAB183 colors	Pin number	
	Excitation (-) / TEDS class 3 (-)	Black	1	
	Excitation (+)	Blue	2	
	Reserved	White/Black	3	
(1) (10)	Signal ground	Red/Black	4	
	External shunt	Pink/Black	5	
	Reserved	Yellow/Black	6	
	Signal (+)	White	7	
$\begin{pmatrix} & & & & & & & & & & & & & & & & & & &$	Signal (-)	Red	8	
(5) (6)	120 Ω -¼ bridge	Brown	9	
	350 Ω -¼ bridge	Yellow	10	
Figure 31: Cable connector soldering view	Sense (-) / TEDS class 3 +	Grey	11	
	Sense (+)	Green	12	
	TEDS class 2 (-)	Grey/Black	13	
	TEDS class 2 (+)	Green/Black	14	

Analog to Digital Conversion			
Sample rate; per channel	0.1 S/s to 500 kS/s		
ADC resolution; one ADC per channel	24 bit		
ADC type	Sigma Delta (Σ-Δ) ADC; Texas Instruments® ADS127L01		
Time base accuracy	Defined by mainframe: ± 3.5 ppm; aging after 10 years ± 10 ppm		

### **Anti-Alias Filters**

Note on phase matching channels. Every filter characteristic and/or filter bandwidth selection comes with it's own specific phase response. Using different filter selections (Wideband/Bessel IIR/Butterworth IIR/etc.) or different filter bandwidths can result in phase mismatches between channels.

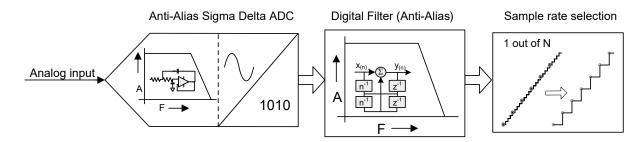


Figure 32: Combined analog and digital anti-alias filter block diagram

Anti-aliasing is prevented by a steep, fixed frequency analog anti-alias filter integrated inside the Sigma Delta Analog to Digital Converter (ADC) always sampling at a fixed sample rate. This setup avoids the need for other analog anti-alias filters.

Directly behind the ADC, the high precision digital filter is used as anti-alias protection before the digital downsampling to the desired user sample rate is performed. The digital filter is programmed to a fraction of the user sample rate and automatically tracks any user sample rate selection. Compared to analog anti-alias filters, the programmable digital filter offers additional benefits like higher order filter with steep roll-off, a larger selection of filter characteristics, noise-free digital output and no additional phase shifts between channels that use the same filter settings.

Sigma Delta Wideband	When Sigma Delta wideband is selected the built-in anti-alias filter of the Sigma Delta ADC (no digital filter) is always in the signal path. Therefore, the anti-alias protection is always active when Sigma Delta wideband is selected.
Bessel IIR	When Bessel IIR filter is selected, this is always a combination of the anti-alias filter built-in the Sigma Delta ADC and a digital Bessel IIR filter to prevent aliasing at lower sample rates.  Bessel filters are typically used when looking at signals in the time domain. They are best used for measuring transient signals or sharp edge signals like square waves or step responses.
Butterworth IIR	When Butterworth IIR filter is selected, this is always a combination of the anti-alias filter built-in the Sigma Delta ADC and a digital Butterworth IIR filter to prevent aliasing at lower sample rates.  This filter is best used when working in the frequency domain. When working in the time domain, this filter is best used for signals that are (close to) sine waves.
Elliptic IIR	When Elliptic IIR filter is selected, this is always a combination of the anti-alias filter built-in the Sigma Delta ADC and a digital Elliptic IIR filter to prevent aliasing at lower sample rates.  This filter is best used when working in the frequency domain. When working in the time domain, this filter is best used for signals that are (close to) sine waves.
Elliptic Bandpass IIR	When Elliptic Bandpass IIR filter is selected, this is always a combination of the built-in anti-alias filter of the Sigma Delta ADC and a digital Elliptic Bandpass IIR filter. Elliptic Bandpass filters are best used when working in the frequency domain. When working in the time domain, this filter is best used for signals that are (close to) sine waves.

#### Bandwidth and Filter Characteristic Selection versus Sample Rate The digital filter before decimation guarantees a superior phase match, ultra-low noise and alias free result. Digital lowpass filters (alias free) AA-filter<sup>(1)</sup> Digital bandpass(2) Butterworth IIR Elliptic IIR ≅ ≝ ≅ Bessel IIR Butterworth II Elliptic IIR Bessel IIR Butterworth II Elliptic IIR Bessel IIR Butterworth II Elliptic IIR Sigma Delta Elliptic IIR Bessel IIR User selectable 1/4 Fs 1/10 Fs 1/40 Fs 1/100 Fs **Highpass** sample rates 1/20 Fs Lowpass 500 kS/s **Σ**Δ Wideband 125 kHz 50 kHz 25 kHz 12.5 kHz 5 kHz 400 kS/s **Σ**Δ Wideband 100 kHz 40 kHz 20 kHz 10 kHz 4 kHz 250 kS/s **ΣΔ** Wideband 62.5 kHz 25 kHz 12.5 kHz 6.25 kHz 2.5 kHz 200 kS/s **Σ**Δ Wideband 50 kHz 20 kHz 10 kHz 5 kHz 2 kHz 125 kS/s **Σ**Δ Wideband 31.25 kHz 12.5 kHz 6.25 kHz 2.5 kHz 1.25 kHz 100 kS/s **ΣΔ** Wideband 25 kHz 10 kHz 2 kHz 1 kHz 5 kHz 50 kS/s **Σ**Δ Wideband 12.5 kHz 5 kHz 2.5 kHz 1.25 kHz 500 Hz 40 kS/s **Σ**Δ Wideband 10 kHz 4 kHz 2 kHz 1 kHz 400 Hz 25 kS/s **Σ**Δ Wideband 6.25 kHz 2.5 kHz 1.25 kHz 625 Hz 250 Hz 20 kS/s **Σ**Δ Wideband 5 kHz 2 kHz 1 kHz 500 Hz 200 Hz 12.5 kS/s **Σ**Δ Wideband 3.125 kHz 1.25 kHz 625 Hz 312.5 Hz 125 Hz 10 kS/s **Σ**Δ Wideband 2.5 kHz 1 kHz 500 Hz 250 Hz 100 Hz 5 kS/s **Σ**Δ Wideband 1.25 kHz 500 Hz 250 Hz 125 Hz 50 Hz 1 kHz, 2 kHz, 4 kS/s **ΣΔ** Wideband 1 kHz 400 Hz 200 Hz 100 Hz 40 Hz 50 Hz, 5 kHz, 2.5 kS/s **Σ**Δ Wideband 625 Hz 250 Hz 125 Hz 62.5 Hz 25 Hz 100 Hz, 10 kHz, 2 kS/s **Σ**Δ Wideband 500 Hz 200 Hz 100 Hz 50 Hz 20 Hz 200 Hz, 12.5 kHz, 500 Hz 25 kHz, 1.25 kS/s **ΣΔ** Wideband 312.5 Hz 125 Hz 62.5 Hz 31.25 Hz 12.5 Hz 50 kHz. 100 kHz 1 kS/s **ΣΔ** Wideband 250 Hz 100 Hz 50 Hz 25 Hz 10 Hz 500 S/s **ΣΔ** Wideband 125 Hz 50 Hz 25 Hz 12.5 Hz 5 Hz **ΣΔ** Wideband 100 Hz 4 Hz 400 S/s 40 Hz 20 Hz 10 Hz 250 S/s **ΣΔ** Wideband 62.5 Hz 25 Hz 12.5 Hz 6.25 Hz 2.5 Hz 200 S/s **ΣΔ** Wideband 50 Hz 20 Hz 10 Hz 2 Hz 5 Hz **ΣΔ** Wideband 12.5 Hz 125 S/s 31.25 Hz 6.25 Hz 3.125 Hz 1.25 Hz 100 S/s **ΣΔ** Wideband 10 Hz 2.5 Hz 1 Hz 25 Hz 5 Hz 50 S/s **Σ**Δ Wideband 12.5 Hz 5 Hz 2.5 Hz 1.25 Hz 0.5 Hz 40 S/s **ΣΔ** Wideband 10 Hz 4 Hz 2 Hz 0.5 Hz 0.4 Hz 6.25 Hz 2.5 Hz 0.625 Hz 0.25 Hz 25 S/s **ΣΔ** Wideband 1.25 Hz 20 S/s **Σ**Δ Wideband 5 Hz 2 Hz 0.5 Hz 0.5 Hz 0.2 Hz 12.5 S/s **ΣΔ** Wideband 3.125 Hz 1.25 Hz 0.625 Hz 0.3125 Hz 0.125 Hz 10 S/s **ΣΔ** Wideband 2.5 Hz 1 Hz 0.5 Hz 0.25 Hz 0.1 Hz

<sup>(1)</sup> Sigma Delta  $\Sigma\Delta$  Wideband prevents aliasing before the digitization of the signal.

<sup>(2)</sup> Digital bandpass filters are selectable in all sample rates.

### Sigma Delta Wideband (Analog Anti-Alias)

When Sigma Delta wideband is selected there is always the anti-alias filter built-in the Sigma Delta ADC (no digital filter) in the signal path. Therefore there is always anti-alias protection when Sigma Delta wideband is selected.

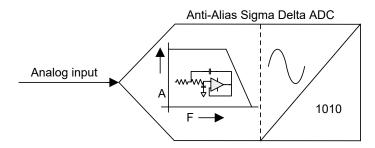
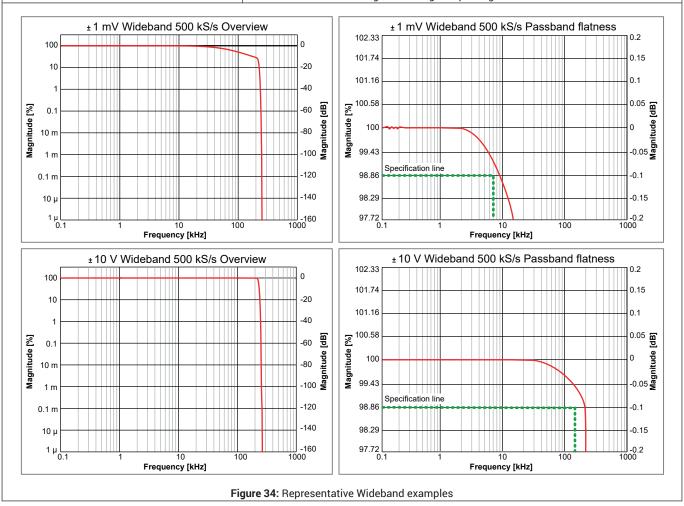
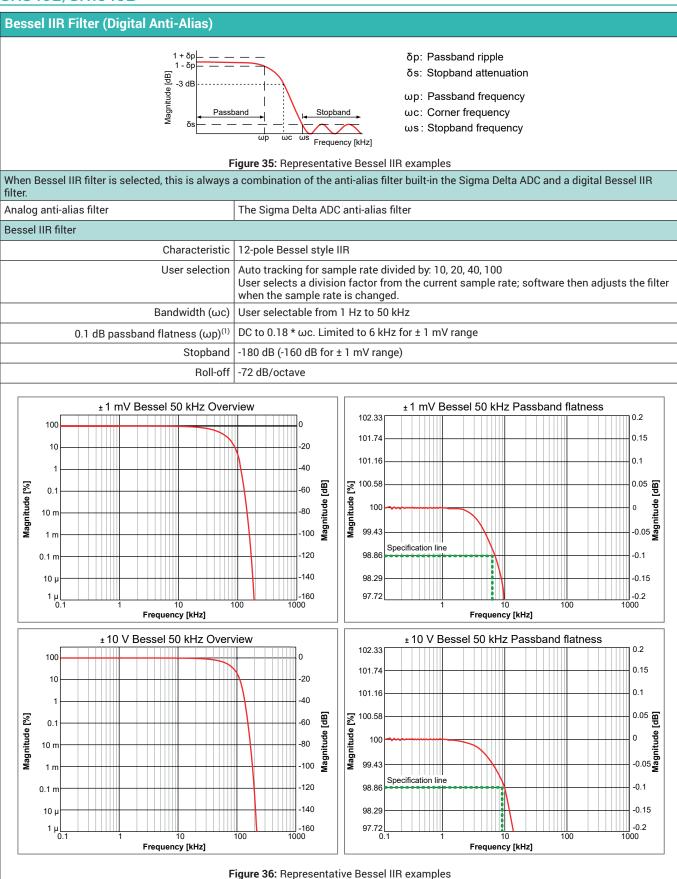


Figure 33: Anti-alias filter built-in (Sigma Delta ADC)

	Wideband -3 dB bandwidth <sup>(1)</sup>	DC to 211 kHz DC to 56 kHz for ± 1 mV range due to high amplifier gain	
	0.1 dB passband flatness <sup>(1)</sup>	DC to 150 kHz DC to 7 kHz for ± 1 mV range due to high amplifier gain	



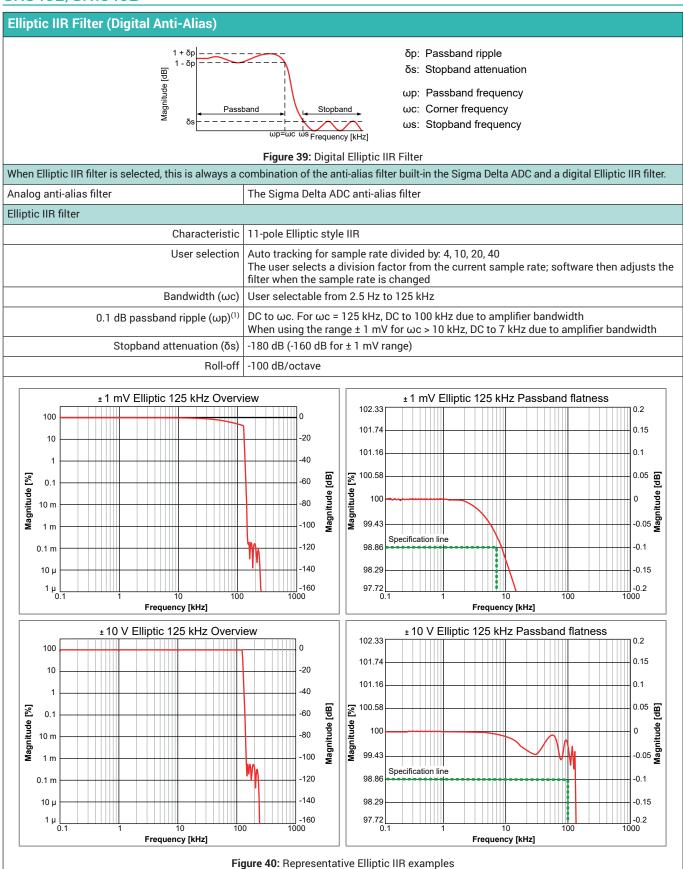
(1) Measured using Fluke 5730A calibrator, DC normalized



(1) Measured using Fluke 5730A calibrator, DC normalized

#### **Butterworth IIR Filter (Digital Anti-Alias)** δp: Passband ripple δs: Stopband attenuation Magnitude [dB] -3 dE ωp: Passband frequency ωc: Corner frequency Passband ωs: Stopband frequency Frequency [kHz] Figure 37: Representative Digital Butterworth IIR Filter When Butterworth IIR filter is selected, this is always a combination of the anti-alias filter built-in the Sigma Delta ADC and a digital Butterworth IIR filter. Analog anti-alias filter The Sigma Delta ADC anti-alias filter Butterworth IIR filter Characteristic 12-pole Butterworth style IIR User selection Auto tracking for sample rate divided by: 4, 10, 20, 40 User selects a division factor from the current sample rate; software then adjusts the filter when the sample rate is changed User selectable from 2.5 Hz to 125 kHz Bandwidth (ωc) DC to $0.8 * \omega c$ . Limited to 7 kHz for $\pm 1$ mV range 0.1 dB passband (ωp) (1) Stopband attenuation (δs) -180 dB (-160 dB for ± 1 mV range) Roll-off -72 dB/octave ± 1 mV Butterworth 125 kHz Overview ±1 mV Butterworth 125 kHz Passband flatness 102.33 0.2 100 101.74 0.15 10 101.16 Magnitude [%] 100.58 100 99.43 Magnitude [%] ∥agnitude [dB] 0.1 -60 -80 10 n 1 m 100 Specification line 120 98.86 -0.1 0.1 m 140 -0.15 10 L 98.29 -160 97.72 L 0.1 ∭-0.2 1000 Frequency [kHz] Frequency [kHz] ± 10 V Butterworth 125 kHz Overview ± 10 V Butterworth 125 kHz Passband flatness 102.33 0.2 100 101.74 -20 10 101.16 줄 <sup>100.58</sup> 0.05 Magnitude [%] Magnitude [dB] -60 0 Magnitude [ Magnitude 100 10 m 99.43 -100 1 m Specification line 98.86 0.1 m 120 0.1 98.29 -0.15 10 L ∭-160 1000 97.72 L 0.1 Frequency [kHz] Frequency [kHz] Figure 38: Representative Butterworth IIR examples

(1) Measured using Fluke 5730A calibrator, DC normalized



(1) Measured using Fluke 5730A calibrator, DC normalized

#### Elliptic IIR Bandpass Filter (Digital Anti-Alias) δp: Passband ripple Magnitude [dB] δs: Stopband attenuation ωp: Passband frequency Band Pass Low Pass Stopband Passband ωc: Corner frequency ωs: Stopband frequency Figure 41: Representative Digital Elliptic IIR Bandpass Filter When Elliptic IIR filter is selected, this is always a combination of the built-in anti-alias filter of the Sigma Delta ADC and a digital Elliptic IIR filter. Analog anti-alias filter The Sigma Delta ADC anti-alias filter Elliptic IIR Bandpass filter Characteristic 12th order Elliptic style IIR User selection Fixed high pass frequencies to be combined with fixed low pass frequencies High pass bandwidth (ωhc) 500 Hz, 200 Hz, 100 Hz, 50 Hz High pass stopband frequency (ωhs) Approximately ωhc / 2.5 Low pass bandwidth (ωlc) 125 kHz, 100 kHz, 50 kHz, 25 kHz, 12.5 kHz, 10 kHz, 5 kHz, 2 kHz, 1 kHz Approximately 1.5 to 2.5 \* ωc Low pass stopband frequency (ωls) who to ωlo, limited to 7 kHz for ± 1 mV range 0.1 dB passband flatness $(\omega p)^{(1)}$ High pass stopband attenuation (δhs) - 90 dB -180 dB (-160 dB for ± 1 mV range) Low pass stopband attenuation (δls) ±1 mV Elliptic Bandpass 50 Hz - 125 kHz Overview ±1 mV Elliptic Bandpass 50 Hz - 125 kHz Passband flatness 102.33 100 101.74 10 -20 101.16 줄 100.58 0.05 E E a B Magnitude [%] -60 0 Magnitude [ Magnitude 100 10 n 99.43 1 n 100 Specification line 98.86 0.1 n 120 -0.1 140 98.29 10 u -0.15 \_\_\_\_\_-160 1000 1 μ <u>\_\_\_</u> 0.001 97.72 -0.2 Frequency [kHz] Frequency [kHz] ± 10 mV Elliptic Bandpass 50 Hz - 125 kHz Overview ± 10 mV Elliptic Bandpass 50 Hz - 125 kHz Passband flatness 102.33 100 101.74 10 -20 101.16 0.05 <u>≅</u> 100.58 圆 Magnitude [%] 0 O.05 Wagnitude 100 -80 10 m 99.43 -100 Specification line 98.86 -120 -0.1 140 98 29 -0 15 ــــا-160 1000 97.72 L 0.01 -0.2 1 μ L\_\_\_ 0.001 0.01 Frequency [kHz] Frequency [kHz] Figure 42: Representative Elliptic IIR Bandpass examples

(1) Measured using Fluke 5730A calibrator, DC normalized

804170\_05\_E00\_00 31/10/2023 27

### **Channel to Channel Phase Match**

Using different filter selections (Wideband/Bessel IIR/Butterworth IIR/etc.) or different filter bandwidths results in phase mismatches between channels. Specifications valid for channel to channel and card to card, all specifications are typical statistical values and measured using a 500 kS/s sample rate with sine wave ranging from 100 Hz to 100 kHz or filter frequency, whichever is reached first.

	Range ±1 mV	Ranges ≥ ±10 mV	Ranges combined
Wideband	200 ns	30 ns	200 ns
Bessel IIR	100 ns	30 ns	100 ns
Butterworth IIR	100 ns	30 ns	100 ns
Elliptic IIR	110 ns	30 ns	110 ns
Elliptic IIR Bandpass	80 ns	30 ns	80 ns
GN840B/GN1640B channels across mainframes	Defined by synchronization method used (None, IRIG, GPS, Master/Sync, PTP)		

### **Channel to Channel Crosstalk**

Channel to channel crosstalk is measured with a 50  $\Omega$  termination resistor on the input and uses sine wave signals on the channel above and below the channel being tested. To test Channel 2, Channel 2 is terminated with 50  $\Omega$  and Channels 1 and 3 are connected to the sine wave generator.

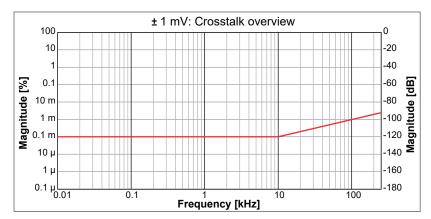
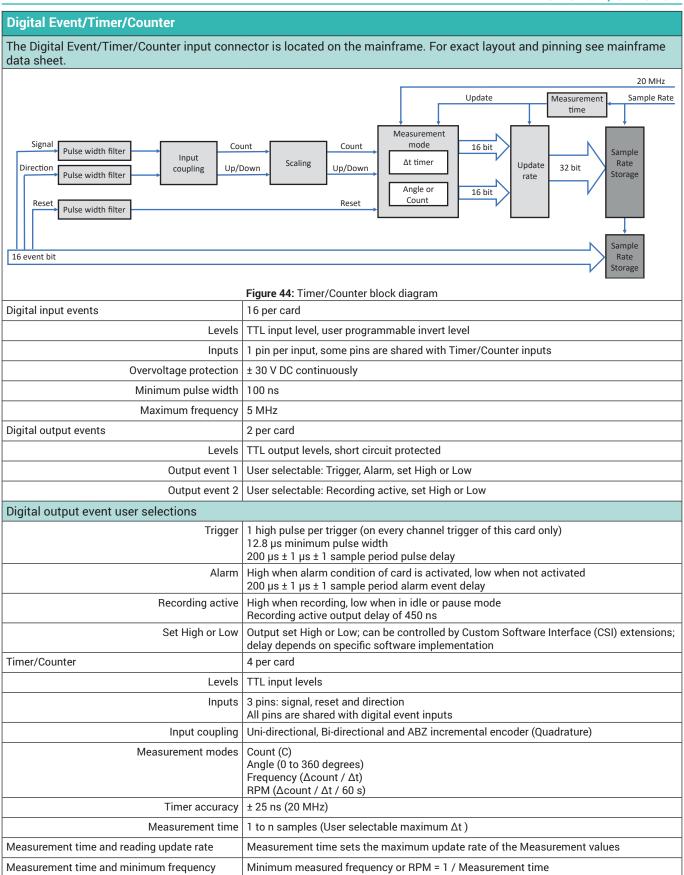


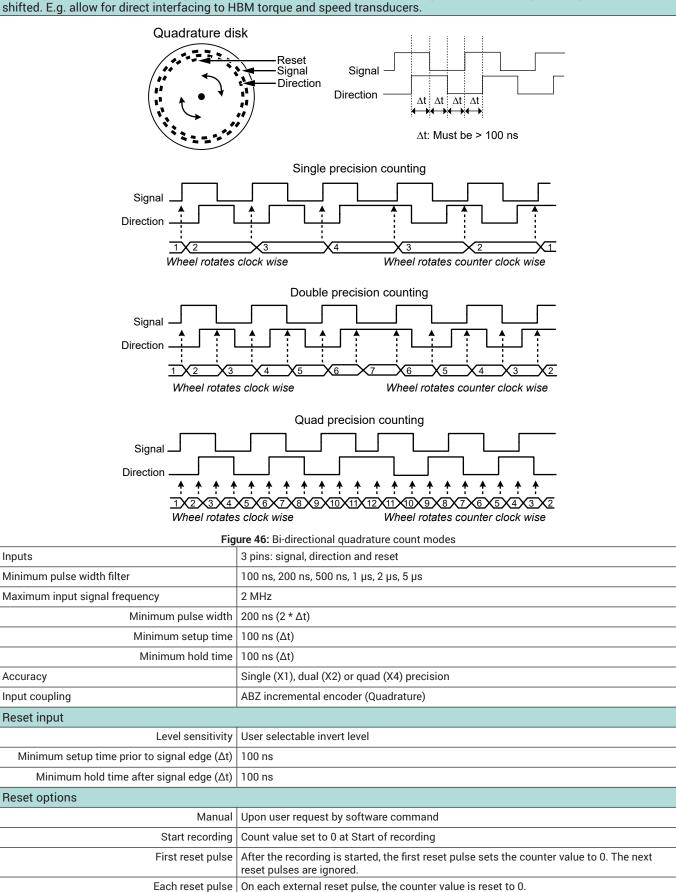
Figure 43: Representative Channel to Channel crosstalk



### Input Coupling Uni- and Bi-directional Signal Uni- and bi-directional input coupling is used when the direction signal is a stable signal. $\Delta s$ Signal Direction Reset 6 Count up Count down Reset Figure 45: Uni- and Bi-directional timing Inputs 3 pins: signal, reset and direction (only used in bi-directional count) Minimum pulse width filter 100 ns, 200 ns, 500 ns, 1 $\mu$ s, 2 $\mu$ s, 5 $\mu$ s Maximum input signal frequency 4 MHz Minimum pulse width ( $\Delta w$ ) 100 ns Reset input Level sensitivity | User selectable invert level Minimum setup time prior to signal edge ( $\Delta$ s) 100 ns Minimum hold time after signal edge ( $\Delta h$ ) 100 ns Reset options Upon user request by software command Manual Start recording Count value set to 0 at Start of recording First reset pulse After the recording is started, the first reset pulse sets the counter value to 0. The next reset pulses are ignored. Each reset pulse On each external reset pulse, the counter value is reset to 0. **Direction input** Input Level sensitivity Only used when in bi-directional mode Low: increment counter/positive frequency High: decrement counter/negative frequency Minimum setup time prior to signal edge ( $\Delta$ s) 100 ns Minimum hold time after signal edge ( $\Delta h$ ) 100 ns

### Input Coupling ABZ Incremental Encoder (Quadrature)

Typically used for tracking rotating/moving devices using a decoder with two signals that are always 90 degree phase shifted. E.g. allow for direct interfacing to HBM torque and speed transducers.

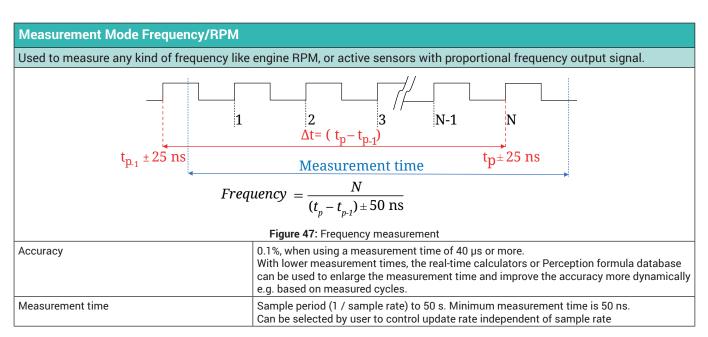


804170\_05\_E00\_00 31/10/2023 31

### **Measurement Mode Angle**

In angle measurement mode the counter will use a user defined maximum angle and revert back to zero when this count value is reached. Using the reset input the measured angle can be synchronized to the mechanical angle. The real-time calculators can extract the RPM from the measured angle independent from the mechanical synchronization.

Angle options	
Reference	User selectable. Enables the use of the reset pin to reference the mechanical angle to the measured angle
Angle at reference point	User defined to specify mechanical reference point
Reset pulse	Angle value is reset to user defined "angle at reference point" value
Pulses per rotation	User defined to specify the encoder/count resolution
Maximum pulses per rotation	32767
Maximum RPM	30 * sample rate (Example: Sample rate 10 kS/s means maximum 300 k RPM)



Measurement Mode Count/Position		
Count/position mode is typically used for tracking movement of device under test.  To reduce the sensitivity for count/position errors due to clock glitches use the minimum pulse width filter or enable the AB in stead of uni-/bipolar input coupling.		
Counter range	0 to 2 <sup>31</sup> ; uni-directional count -2 <sup>31</sup> to +2 <sup>31</sup> - 1; bi-directional count	

### **Maximum Timer Inaccuracy**

50 ms

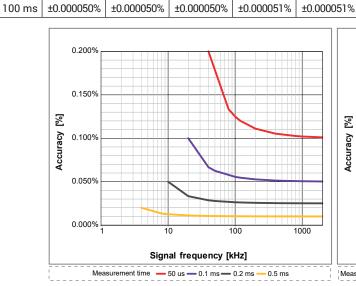
±0.00010%

±0.00010%

Timer accuracy is a tradeoff between update rate and minimum required accuracy. This table shows the relationships between measured signal frequency, selected measurement time (update rate) and timer accuracy. The inaccuracy distribution is to be considered rectangular.

Calculate the inaccuracy by using:  $Inaccuracy = \pm \left( \frac{(signal\ frequency\ *50\ ns)}{INTEGER\ ((signal\ frequency\ -1)\ *\ measurement\ time)} \right) * 100\%$ 

Mea-	Higher signal frequencies: Signal frequency (2 MHz down to 10 kHz)									
sure- ment	2 MHz	1 MHz	500 kHz	400 kHz	200 kHz	100 kHz	50 kHz	40 kHz	20 kHz	10 kHz
1 µs	±10.000%									
2 μs	±3.333%	±5.000%								
5 µs	±1.111%	±1.250%	±1.333%	±2.000%						
10 µs	±0.526%	±0.556%	±0.625%	±0.667%	±1.000%					
20 µs	±0.256%	±0.263%	±0.278%	±0.286%	±0.333%	±0.500%				
50 µs	±0.101%	±0.102%	±0.103%	±0.105%	±0.111%	±0.125%	±0.133%	±2.000%		
0.1 ms	±0.050%	±0.051%	±0.051%	±0.051%	±0.053%	±0.056%	±0.063%	±0.067%	±0.100%	
0.2 ms		±0.0	)25%		±0.026%	±0.026%	±0.028%	±0.029%	±0.033%	±0.050%
0.5 ms			±0.010%			±0.010%	±0.010%	±0.0011%	±0.0011%	±0.0013%
1 ms			±0.0050%			±0.0051%	±0.0051%	±0.0051%	±0.0053%	±0.0056%
2 ms				±0.00	025%				±0.0026%	±0.0026%
5 ms					±0.00	010%				
10 ms					±0.00	005%				
20 ms					±0.00	025%				
50 ms					±0.00	010%				
100 ms					±0.00	005%				
Mea-			Lov	ver signal free	quencies: Sig	nal frequency	(40 Hz to 5 k	Hz)		
sure- ment	5 kHz	4 kHz	2 kHz	1 kHz	500 Hz	400 Hz	200 Hz	100 Hz	50 Hz	40 Hz
0.5 ms	±0.0133%	±0.0200%								
1 ms	±0.0063%	±0.0067%	±0.0100%							
2 ms	±0.0028%	±0.0029%	±0.0033%	±0.0050%						
5 ms	±0.0010%	±0.0011%	±0.0011%	±0.0013%	±0.0013%	±0.0020%				
10 ms	±0.00051%	±0.00051%	±0.00053%	±0.00056%	±0.00063%	±0.00067%	±0.00100%			
20 ms	±0.00025%	±0.00025%	±0.00026%	±0.00026%	±0.00028%	±0.00029%	±0.00033%	±0.00050%		



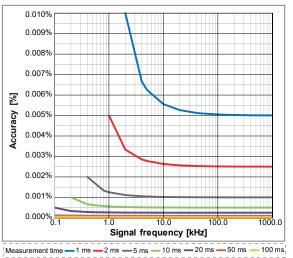
±0.00010%

±0.00010%

±0.00010%

±0.00011%

±0.000051%



±0.00011%

±0.000053%

±0.00130%

±0.000056%

±0.00013%

±0.000063%

±0.00020%

±0.000067%

Figure 48: Maximum Timer Inaccuracy

804170\_05\_E00\_00 31/10/2023 33

### **Torque Measurement Uncertainty using Frequency Measurements**

When using the Timer/Counter channels to measure torque, the measurement uncertainty introduced by the timer inaccuracies can be calculated using the following examples based on HBK T40 torque transducers.

The T40 torque transducer comes with 3 variants for frequency output: 10 kHz, 60 kHz or 240 kHz center frequency. From the data sheets you can extract the minimum and maximum frequency output like table below.

T40 Variant	-Full Scale frequency output	+Full Scale frequency output
T40 - 10 kHz	5 kHz	15 kHz
T40 - 60 kHz	30 kHz	90 kHz
T40 - 240 kHz	120 kHz	360 kHz

Overlay these operating ranges on top of the timer inaccuracy plots of Figure 48 will result in Figure 49 (see below).

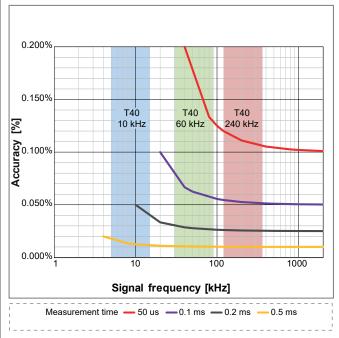
- Remains the step to balance the update rate (torque bandwidth) versus the torque accuracy required.
- Calculate the inaccuracy using the -Full Scale frequency output and desired measurement time.
- Using a minimum of 60 RPM the following inaccuracies are calculated.

Selected measurement time	Maximum inaccuracy: T40 - 240 kHZ	Maximum inaccuracy: T40 - 60 kHZ	Maximum inaccuracy: T40 - 10 kHZ
50 μs (left red curve)	0.1200%	0.1500%	Not possible
100 μs (left purple curve)	0.0546%	0.0750%	Not possible
500 μs (left orange curve)	0.0101%	0.0107%	0.0125%
1 ms (right blue curve)	0.0050%	0.0052%	0.0063%
2 ms (right red curve)	0.0025%	0.0025%	0.0028%
5 ms (right grey curve)	0.0010%	0.0010%	0.0010%

For K=1 (70% probability) use the specified rectangular distribution and the maximum inaccuracy numbers and calculate:

Measurement uncertainty = Maximum inaccuracy \* 0.58 (Conversion for rectangular distribution)

measurement uncertainty - Maximum inacturacy 0.30 (conversion for rectangular distribution)				
Measurement uncertainty K=1 (About 70% probability)	Maximum inaccuracy: T40 - 240 kHZ	Maximum inaccuracy: T40 - 60 kHZ	Maximum inaccuracy: T40 - 10 kHZ	
50 μs (left red curve)	0.0696%	0.0870%	Not possible	
100 μs (left purple curve)	0.0316%	0.0435%	Not possible	
500 μs (left orange curve)	0.0059%	0.0062%	0.00725%	
1 ms (right blue curve)	0.0029%	0.0029%	0.00365%	
2 ms (right red curve)	0.00145%	0.0015%	0.00162%	
5 ms (right grey curve)	0.00058%	0.0006%	0.00058%	



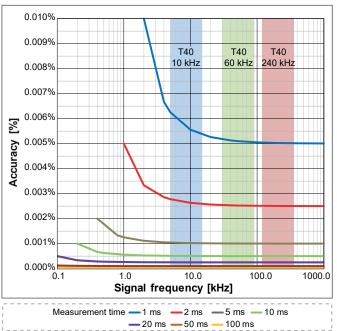


Figure 49: Torque operating range versus inaccuracy and measurement time

### Speed (RPM) Measurement Uncertainty using Frequency Measurements

When using the Timer/Counter channels to measure speed (RPM), the measurement uncertainty introduced by the timer inaccuracies can be calculated using the following example.

In the data sheet of the speed sensor locate the specified number of pulse per rotation to calculate the frequency range of the sensor output:

Minimum frequency = minimum RPM used during testing \* number of pulse per rotation / 60 sec Maximum frequency = maximum RPM used during testing \* number of pulse per rotation / 60 sec

Speed Sensor pulse per rotation	Frequency at 60 RPM	Frequency at 10 000 RPM	Frequency at 20 000 RPM
180	180 Hz	30 kHz	60 kHz
360	360 Hz	60 kHz	120 kHz
1024	1024 Hz	170.7 kHz	341.3 kHz

Overlay these operating ranges on top of the timer inaccuracy plots of Figure 48 will result in Figure 50 (see below).

- · Remains the step to balance the update rate (torque bandwidth) versus the torque accuracy required.
- Using the graphs find the crossings of the overlayed operating frequencies with the measurement time curves.
- As examples the following crossings can be found in the graphs (at 60 RPM).

Selected measurement time	180 pulse sensor	360 pulse sensor	1024 pulse sensor
2 ms (red curve)	Can't record at 60 RPM	Can't record at 60 RPM	0.00256%
5 ms (grey curve)	Can't record at 60 RPM	0.0018%	0.0010%
10 ms (Green curve)	0.0009%	0.0006%	0.00051%

For K=1 (70% probability) use the specified rectangular distribution and the maximum inaccuracy numbers and calculate:

Measurement uncertainty = Maximum inaccuracy \* 0.58 (Conversion for rectangular distribution)

Measurement uncertainty K=1 (About 70% probability)	180 pulse sensor	360 pulse sensor	1024 pulse sensor
	Can't record at 60 RPM	Can't record at 60 RPM	0.00148%
5 ms (grey curve)	Can't record at 60 RPM	0.00104%	0.00059%
10 ms (Green curve)	0.00052%	0.00035%	0.00030%

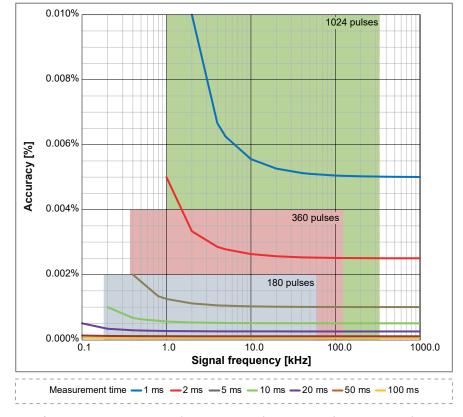


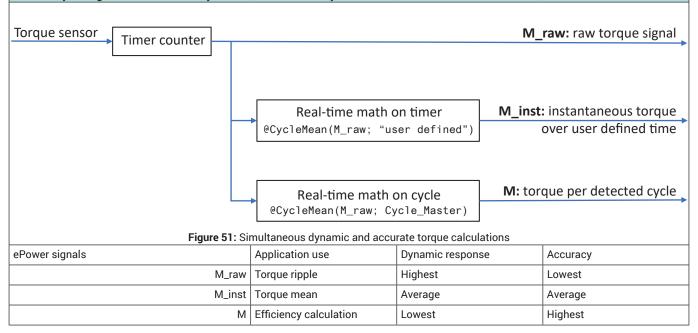
Figure 50: RPM sensor operating range versus inaccuracy and measurement time

### Simultaneous Dynamic Torque Ripple and Accurate Torque Efficiency Measurement

If a high update rate is required to measure e.g. dynamic torque ripple yet for efficiency a high accuracy is required use both a measurement time of 50 µs as well as a RT-FDB function to calculate the mean value for each electric cycle.

The measured torque signal coming from the timer counter will be 0.15 to 0.17% accurate, while the torque calculate for the electric cycle (typically being 1 ms or less) results in 0.0075% accuracy.

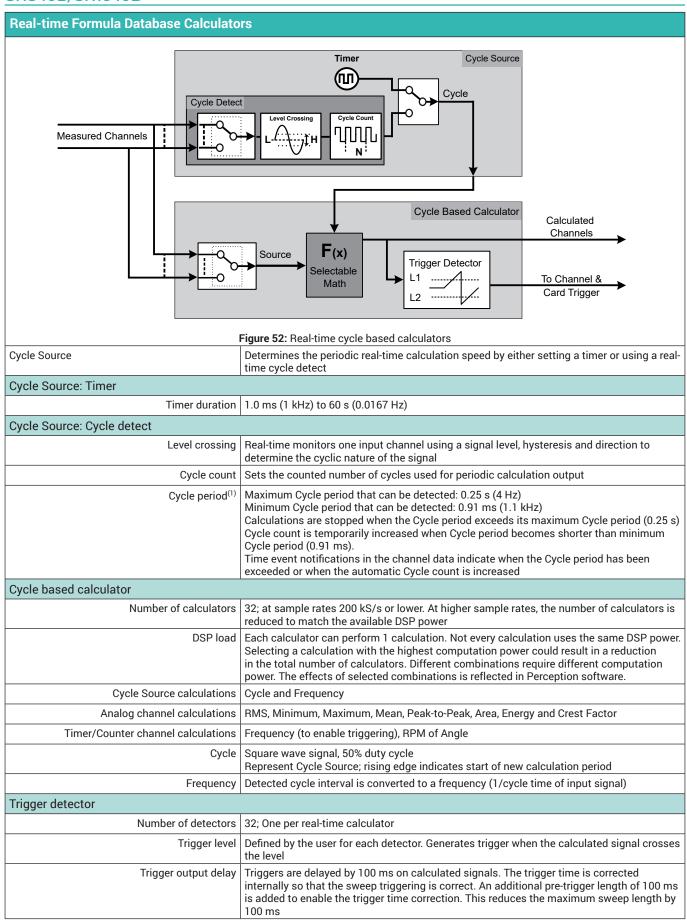
As both signals are simultaneously available, the dynamic signal allows you to analyse the torque ripple behaviour, the electric cycle signal will be extremely accurate for efficiency calculations.



Alarm Output			
Event channel alarm modes	High or low level check		
Cross channel alarms	Logical OR of alarms from all measured channels		
Alarm output	Active during valid alarm condition, output supported through mainframe		
Alarm output level	High or low user selectable		
Alarm output delay	515 µs ± 1 µs + maximum 1 sample period. Default 516 µs, compatible with standard behavior. Minimum selectable delay is the smallest delay available for all acquisition cards used within the mainframe. Delay equal to Trigger Out delay.		
Selection per card	User selectable On/Off		
Analog channel alarm modes			
Basic	Above or below level check		
Dual	Outside or within bounds check		
Analog channel alarm levels			
Levels	Levels Maximum 2 level detectors		
Resolution	16 bit (0.0015%) for each level		

Triggering	
Channel trigger/qualifier	1 per channel; fully independent per channel, software selectable either trigger or qualifier
Pre- and post-trigger length	0 to full memory
Maximum trigger rate	400 triggers per second
Maximum delayed trigger	1000 seconds after a trigger occurred
Manual trigger (Software)	Supported
External Trigger In	
Selection per card	User selectable On/Off
Trigger In edge	Rising/Falling mainframe selectable, identical for all cards
Minimum pulse width	500 ns
Trigger In delay	± 1 μs + maximum 1 sample period
Send to External Trigger Out	User can select to forward External Trigger In to the External Trigger Out BNC
External Trigger Out	
Selection per card	User selectable On/Off
Trigger Out level	High/Low/Hold High; mainframe selectable, identical for all cards
Trigger Out pulse width	High/Low: 12.8 µs Hold High: Active from first mainframe trigger to end of recording Pulse width created by mainframe; For details, please refer to the mainframe data sheet
Trigger Out delay	Selectable (10 $\mu$ s to 516 $\mu$ s) $\pm$ 1 $\mu$ s + maximum 1 sample period Default 516 $\mu$ s, compatible with standard behavior. Minimum selectable delay is the smallest delay available for all acquisition cards used within the mainframe
Cross channel triggering	
Measurement channels	Logical OR of triggers from all measured signals Logical AND of qualifiers from all measured signals
Calculated channels	Logical OR of triggers from all calculated signals (RT-FDB) Logical AND of qualifiers from all calculated signals (RT-FDB)
Analog channel trigger levels	
Levels	Maximum 2 level detectors
Resolution	16 bit (0.0015%) for each level
Direction	Rising/Falling; single direction control for both levels based on selected mode
Hysteresis	0.1 to 100% of Full Scale; defines the trigger sensitivity
Pulse detect/reject	Disable/Detect/Reject selectable. Maximum pulse width 65 535 samples
Analog channel trigger modes	
Basic	POS or NEG crossing; single level
Dual Level	One POS and one NEG crossing; two individual levels, logical OR
Analog channel qualifier modes	
Basic	Above or below level check. Enable/Disable trigger with single level
Dual	Outside or within bounds check. Enable/Disable trigger with dual level
Event channel trigger	
Event channels	Individual event trigger per event channel
Levels	Trigger on rising edge, falling edge or both edges
Qualifiers	Active High or Active Low for every event channel

On-board Memory	
Per card	2 GB (1 GSample @ 16 bits, 500 MS @ 24 bits storage)
Organization	Automatic distribution amongst enabled channels
Memory diagnostics	Automatic memory test when system is powered and not recording
Storage sample size	16 bits, 2 bytes / sample 24 bits, 4 bytes / sample



<sup>(1)</sup> Cycle period range depends on signal wave shape and hysteresis setting. Specified for Sine wave with 25% Full Scale hysteresis.

## Real-time Formula Database Calculators (Option to be ordered separately)

The real-time formula database (RT-FDB) option offers an extensive set of math routines to enable almost any real-time mathematical challenge. The database structure enables the user to define a list of mathematical equations similar to the Perception review formula database.

The maximum supported sample rate is 2 MS/s.

Different versions of Perception can enable more or less features as described in GEN DAQ the mainframes manuals.

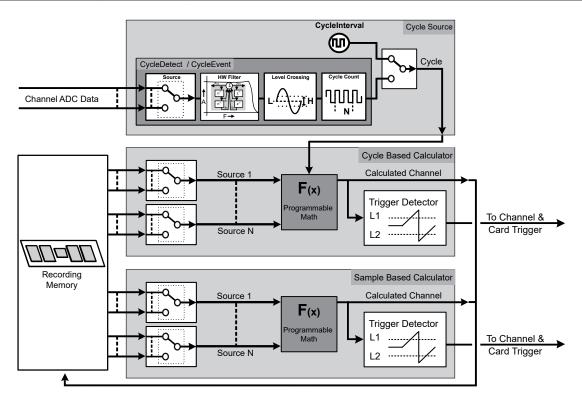


Figure 53: Real-time formula database (RT-FDB) calculators

The real-time formula database supports the following list of calculations (Details of each calculation are described in the manual).

Group	Available RT-FDB functions		
Basic			
	+ (add)	* (multiply)	
	- (subtract)	/ (divide)	
Boolean			
	AlarmOnLevel	Not	ToAsyncBoolean
	And	NotEqual	TriggerArmOnBooleanChange
	Equal	OneShotTimer	TriggerOnBooleanChange
	GreaterEqualThan	Or	TriggerOnLevel
	GreaterThan	OutsideBand	Xor
	InsideBand	SetAlarm	
		StartStopTriggerOnBooleanChange	
		StopTriggerOnBooleanChange	

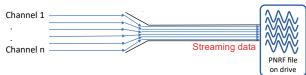
# GN840B/GN1640B

Real-time	time Formula Database Calculators (Option to be ordered separately)				
Group	Available RT-FDB functions				
Cycle					
	CycleArea	CycleFundamentalPhase	CycleNOP		
	CycleBusDelay	CycleFundamentalRMS	CyclePeak2Peak		
	CycleCount	CycleHarmonicPhase	CyclePhase		
	CycleCrestFactor	CycleHarmonicRMS	CycleRMS		
	CycleDetect	CycleInterval	CycleRPM		
	CycleEnergy	CycleMax	CycleSampleCount		
	CycleEvent	CycleMean	CycleStdDev		
	CycleFrequency	CycleMin	CycleTHD		
			ExternalCycleEvent		
eDrive					
	AronConversion	EfficiencyValue	SpaceVector		
	DQ0Transformation	HarmonicsIEC61000	SpaceVectorInv		
	EfficiencyMode	PowerLoss			
Enhanced					
	Abs	LessEqualThan	RadiansToDegrees		
	Atan	LessThan	SampleCount		
	Atan2	Max	Sin		
	Cos	Min	Sqrt		
	DegreesToRadians	Minus	Tan		
	Integrate	Modulo			
	IntegrateGated	PureDFT			
Fieldbus					
	SetScalarFromFieldbus				
Filter					
	FilterBesselBP	FilterButterworthBP	FilterChebyshevBP		
	FilterBesselHP	FilterButterworthHP	FilterChebyshevHP		
	FilterBesselLP	FilterButterworthLP	FilterChebyshevLP		
	HWFilter				
Math					
	NumSamplesMean	TimedMean			
	NumSamplesStdDev	TimedStdDev			
Signal generation					
	Ramp				
	Sinewave				

Real-time Statstream®	
	g waveform displays as well as real-time meters while recording. If for displaying and zooming extremely large recordings and it reduces the
Analog channels	Maximum, Minimum, Mean, Peak to Peak, Standard Deviation and RMS values
Event/Timer/Counter channels	Maximum, Minimum and Peak to Peak values

## **Data Recording Modes**

### On start of acquisition



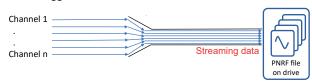
and storage drive used, as well as the PC and drive not being used for

other purposes as data recording, it is strongly recommended for higher aggregate sample rates to test the chosen setup prior to performing vour test.

Data recording to a drive is limited by an aggregate sample rate, the

Note: As the aggregate sample rate limit depends on Ethernet speed

Wait for trigger



Triggered data recording to PC or mainframe drive.

Data recording to PC or mainframe drive.

recording time is limited by the size of drive.

Trigger data recording to a drive is limited by an aggregate sample rate, the recording time is limited by the size of drive.

Note: As the aggregate sample rate limit depends on Ethernet speed and storage drive used, as well as the PC and drive not being used for other purposes as data recording, it is strongly recommended for higher aggregate sample rates to test the chosen setup prior to performing vour test.

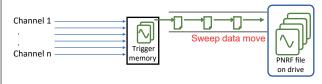
Not recommended for transient/one time only/destructive tests.

Triggered data recording to trigger memory on the acquisition card. Triggered data recording to trigger memory has no sample rate limits, the recording time is limited by the size of trigger memory. Triggered data recorded in trigger memory is moved to a drive as quickly as

Note: This data recording mode guarantees the data will always be recorded according to the user defined settings.

Recommended for transient/one time only/destructive tests.

## Wait for trigger to trigger memory first

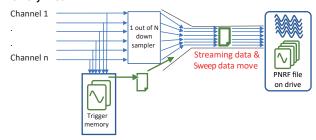


Data recording to PC or mainframe drive and simultaneous triggered data recording to trigger memory on the acquisition card.

The reduced rate data recording to a drive is limited by an aggregate sample rate and the recording time is limited by the size of drive. The triggered data recording to trigger memory has no sample rate limits, the triggered data recording time is limited by the size of trigger memory. The triggered data recorded in trigger memory is moved to a drive as quickly as possible. As this data move happens simultaneously with the reduce rate data recording, it uses bandwidth of the aggregate sample rate.

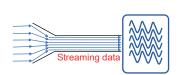
Note: As the aggregate sample rate limit depends on Ethernet speed and storage drive used, as well as the PC and drive not being used for other purposes as data recording, it is strongly recommended for higher aggregate sample rates as well as higher number of triggers per second to test the chosen setup prior to performing your test.

### On start of acquisition reduced rate and wait for trigger to trigger memory first



#### **Data Recording Compared** Trigger **Direct** required to Aggregate sample Maximum recording to **Trigger** start recorded data rate limit drive memory first recording On start of acquisition Yes Free drive space Yes No No Wait for trigger Yes Free drive space Yes Nο Yes Wait for trigger to trigger memory first No Trigger memory No Yes Yes Reduced rate: Yes Free drive space Yes No No On start of acquisition reduced rate and wait for trigger to trigger memory first Sample rate: No Trigger memory Nο Yes Yes

## Aggregate sample rate limits when using streaming data



The maximum aggregate streaming rate per mainframe is defined by mainframe type and solid state drive, Ethernet speed, PC drive and other PC parameters.

When an aggregate sample rate is higher than the aggregate streaming rate of the system is selected, the memory on each acquisition card acts as a FIFO. As soon as this FIFO fills up, the recording is suspended (no data is recorded temporarily). During this period, the FIFO memory is transferred to a drive. When all FIFO's are empty, the recording is automatically resumed. User notifications are added to the recording file for post recording identification of suspended recording.

41 B04170 05 E00 00 31/10/2023

# **Triggered Recording Definitions** The details in this table apply to: Wait for trigger Wait for trigger to trigger memory first On start of acquisition reduced rate and wait for trigger to trigger memory first Stop-trigger Between-trigger Pre-trigger Defined by a trigger signal, pre- and post-trigger data and optionally between-trigger data and/or stop trigger signal. Triggered data segments Pre-trigger data Data recorded prior to a trigger signal. Note: If a trigger signal is received before the full length of pre-trigger data is recorded, the trigger is accepted and the pre-trigger data recorded is automatically reduced to the available pre-trigger data at the time of the trigger. Data recorded after a trigger or stop-trigger signal. Post-trigger data Note: The recording of the post-trigger data can be re-started or delayed depending on the "post-trigger begins on" selection. Between-trigger data Data recorded due to re-trigger(s) or while waiting for the Stop-trigger. The length of between-trigger data is not specified and added based on the timing of the trigger or stoptrigger signals. Trigger signals Trigger signal This signal ends the pre-trigger and starts the post-trigger data recording. See table section "Post-trigger begins on" for more details. A trigger signal can be set up on external input trigger, analog and digital channels as well as using simple to complex RT-FDB formulas. This signal starts the post-trigger data recording when in "post-trigger begins on stop-trigger" mode. Stop-trigger signal See table section "Post-trigger begins on" for more details. A stop-trigger signals can be set up on external input trigger and simple to complex RT-FDB formulas. Post-trigger begins on First trigger Trigger Pre-trigger: 10.00 ms Post-trigger: 20.00 ms The first trigger signal ends the pre-trigger data recording and starts the recording of the post-trigger data. Any **trigger** received during the post-trigger data recording is ignored. Between-trigger data does not exist in this mode. The resulting sweep contains pre- and the post-trigger data Every trigger Trigger Trigger Trigger Pre-trigger: 10.00 ms Post-trigger: 20.00 ms The first trigger ends the pre-trigger data recording and starts the recording of the post-trigger data. Any trigger received during the post-trigger data recording restarts the recording of post-trigger data. All recorded post-trigger data recorded at the time of the trigger is added to the between-trigger data. The resulting sweep contains pre-, between- and the post-trigger data. Stop-trigger Stop-trigger Pre-trigger: 10.00 ms Between-trigger Post-trigger: 20.00 ms The trigger signal ends the pre-trigger data recording and starts the between-trigger data recording. The stop-trigger then ends the between-trigger data recording and starts the post-trigger data recording. Any trigger received during the between-trigger and post-trigger data recording is ignored. Any stop-trigger received during the pre-trigger and post-trigger data recording is ignored. The resulting sweep contains pre-, between- and the post-trigger data

Trigger Memory Filled While Recording			
The trigger memory is limited in size and can easily get filled when using high sample rates combined with high trigger rates. This section explains how triggers are handled when the trigger memory is completely filled.			
Post-trigger begins on	Sweep recording selection		
First trigger	A new sweep is only recorded if both pre- and post-trigger data fits in the free trigger memory at the time a trigger signal is received. When not enough free trigger memory is available, only the trigger time and trigger source get recorded (No pre- or post data is recorded).		
Every trigger	A new sweep is started using the same rules as for the first trigger mode. If during the post-trigger recording a new trigger is received, the sweep is only extended with new post-trigger data if the additional post-trigger data fits the available free trigger memory. When not enough trigger memory is available, the already recorded pre-, between and post-trigger data for the previously received trigger(s) will be recorded.		
Stop-trigger signal	A new sweep is only recorded if both pre-, 2.5 ms between and post-trigger data fits in the free trigger memory at the time a trigger signal is received.  If no stop-trigger signal is received before the trigger memory fills up, the sweep recording is automatically stopped at the time the trigger memory is completely filled.		

# **Triggered Recording Limits**

- The details in this table apply to:

  Wait for trigger

  Wait for trigger to trigger memory first

On start of acquisition reduced rate and wait for trigger to trigger memory first					
	Wait for trigger to trigger memory first				
		On start of acquisition reduced rate and wait for trigger to trigger memory first		Wait for trigger	
Triggered data recording	Limited recor	ding time	Use available	Use available size of drive	
Sample rate	Unlimited sar	mple rates	Low to medium sample rates (Depending on system used)		
Channel count	Unlimited channel count		Low to medium channel counts (Depending on system used)		
Maximum number of sweeps	Maximum number of sweeps				
In trigger memory	2000	2000		Not applicable	
In PNRF recording file	200 000		1		
Sweep parameters	Minimum	Maximum	Minimum	Maximum	
Pre-trigger length	0	Trigger memory of acquisition card	0	Available free drive space	
Post-trigger length	0	Trigger memory of acquisition card	0	0	
Sweep length	10 samples	10 samples Trigger memory of acquisition card		Available free drive space	
Maximum sweeps rate	400/s		Not applicable		
Minimum time between-triggers	2.5 ms		Not applicable		
Dead time between sweeps	0 ms		Not applicable		

#### **Data Recording Details** (1) 16 Bit storage On start of acquisition On start of acquisition reduced Wait for trigger to trigger memory rate and wait for trigger to trigger Wait for trigger first memory first **Enabled channels Enabled channels Enabled channels** 16 Ch 16 Ch 16 Ch Event **Event** Event 1 Ch 8 Ch 16 Ch 1 Ch 8 Ch 16 Ch 1 Ch 8 Ch 16 Ch Ch(s) Ch(s) Ch(s) Max. trigger memory not used 960 MS 120 MS 60 MS 56 MS 768 MS 96 MS 48 MS 44 MS Max. trigger sample not used 500 kS/s 500 kS/s rate 960 MS 120 MS 60 MS 24 MS 12 MS Max. reduced FIFO 56 MS not used 192 MS 11 MS Max. (reduced) sample 500 kS/s not used Trigger Sample Rate / 2 rate Max. aggregate reduced 0.5 MS/s 4 MS/s 8.5 MS/s 0.3 MS/s 4 MS/s 4.5 MS/s 8 MS/s 2 MS/s streaming rate 17 MB/s 0.5 MB/s 9 MB/s 1 MB/s 8 MS/s 16 MB/s not used 4 MB/s 8 MB/s 24 Bit storage On start of acquisition reduced On start of acquisition Wait for trigger to trigger memory rate and wait for trigger to trigger Wait for trigger first memory first **Enabled channels Enabled channels Enabled channels** 16 Ch 16 Ch 16 Ch Event **Event** Event Ch(s) Ch(s) Ch(s) 1 Ch 8 Ch 16 Ch + T/C 1 Ch 8 Ch 16 Ch + T/C 1 Ch 8 Ch 16 Ch + T/C Max. trigger memory not used 480 MS 60 MS 30 MS 25 MS 384 MS 48 MS 24 MS 20 MS Max. trigger sample 500 kS/s 500 kS/s not used Max. reduced FIFO 480 MS 60 MS 30 MS 25 MS not used 96 MS 12 MS 6 MS 5 MS Max. (reduced) sample 500 kS/s Trigger Sample Rate / 2 not used rate Max. aggregate reduced 0.5 MS/s 4 MS/s 8 MS/s 9.5 MS/s 0.3 MS/s 2 MS/s 4 MS/s 4.8 MS/s streaming rate 16 MB/s 32 MB/s 38 MB/s 1 MB/s 8 MB/s 16 MB/s 2 MB/s not used 19 MB/s

<sup>(1)</sup> Terminology used in alignment with Perception software.

Environmental Specifications	
Temperature Range	
Operational	0 °C to +40 °C (+32 °F to +104 °F)
Non-operational (Storage)	-25 °C to +70 °C (-13 °F to +158 °F)
Thermal protection	Automatic thermal shutdown at 85 °C (+185 °F) internal temperature User warning notifications at 75 °C (+167 °F) (Supported by Perception V6.30 or higher)
Relative humidity	0% to 80%; non-condensing; operational
Protection class	IP20
Altitude	Maximum 2000 m (6562 ft) above sea level; operational
Shock: IEC 60068-2-27	
Operational	Half-sine 10 g/11 ms; 3-axis, 1000 shocks in positive and negative direction
Non-operational	Half-sine 25 g/6 ms; 3-axis, 3 shocks in positive and negative direction
Vibration: IEC 60068-2-64	
Operational	1 g RMS, ½ h; 3-axis, random 5 to 500 Hz
Non-operational	2 g RMS, 1 h; 3-axis, random 5 to 500 Hz
Operational Environmental Tests	
Cold test IEC60068-2-1 Test Ad	-5 °C (+23 °F) for 2 hours
Dry heat test IEC 60068-2-2 Test Bd	+40 °C (+104 °F) for 2 hours
Damp heat test IEC 60068-2-3 Test Ca	+40 °C (+104 °F), humidity > 93% RH for 4 days
Non-Operational (Storage) Environmental T	ests
Cold test IEC-60068-2-1 Test Ab	-25 °C (-13 °F) for 72 hours
Dry heat test IEC-60068-2-2 Test Bb	+70 °C (+158 °F) humidity < 50% RH for 96 hours
Change of temperature test IEC60068-2-14 Test Na	-25 °C to +70 °C (-13 °F to +158 °F) 5 cycles, rate 2 to 3 minutes, dwell time 3 hours
Damp heat cyclic test IEC60068-2-30 Test Db variant 1	+25 °C/+40 °C (+77 °F/+104 °F), humidity > 95/90% RH 6 cycles, cycle duration 24 hours

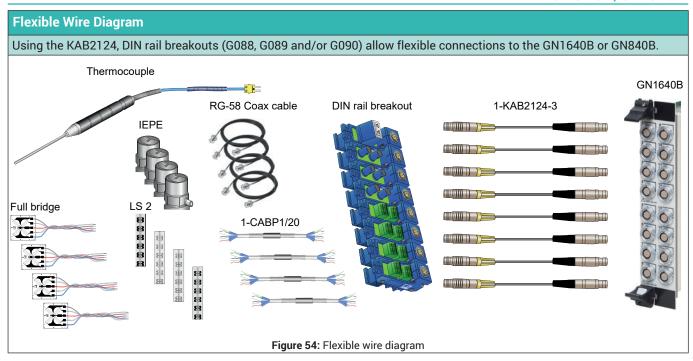
Harmonized Standards for CE and UKCA Compliance, According to the Following Directives <sup>(1)</sup>				
	Low Voltage Directive (LVD): 2014/35/EU Electromagnetic Compatibility Directive (EMC): 2014/30/EU			
Electrical Safety				
EN 61010-1 (2017)	Safety requirements for electrical equipment for measurement, control, and laboratory use - General requirements			
EN 61010-2-030 (2017)	Particular requirements for testing and measuring circuits			
Electromagnetic Com	patibility			
EN 61326-1 (2013)	Electrical equipment for measurement, control and laboratory use - EMC requirements - Part 1: General requirements			
Emission				
EN 55011	Industrial, scientific and medical equipment - Radio-frequency disturbance characteristics Conducted disturbance: class B; Radiated disturbance: class A			
EN 61000-3-2	Limits for harmonic current emissions: class D			
EN 61000-3-3	Limitation of voltage changes, voltage fluctuations and flicker in public low voltage supply systems			
Immunity				
EN 61000-4-2	Electrostatic discharge immunity test (ESD); contact discharge ± 4 kV/air discharge ± 8 kV: performance criteria B			
EN 61000-4-3	Radiated, radio-frequency, electromagnetic field immunity test; 80 MHz to 2.7 GHz using 10 V/m, 1000 Hz AM: performance criteria A			
EN 61000-4-4	Electrical fast transient/burst immunity test Mains ± 2 kV using coupling network. Channel ± 2 kV using capacitive clamp: performance criteria B			
EN 61000-4-5	Surge immunity test Mains $\pm$ 0.5 kV/ $\pm$ 1 kV Line-Line and $\pm$ 0.5 kV/ $\pm$ 1 kV Line-earth Channel $\pm$ 0.5 kV/ $\pm$ 1 kV using coupling network: performance criteria B			
EN 61000-4-6	Immunity to conducted disturbances, induced by radio-frequency fields 150 kHz to 80 MHz, 1000 Hz AM; 10 V RMS @ mains, 3 V RMS @ channel, both using clamp: performance criteria A			
EN 61000-4-11	Voltage dips, short interruptions and voltage variations immunity tests Dips: performance criteria A; Interruptions: performance criteria C			

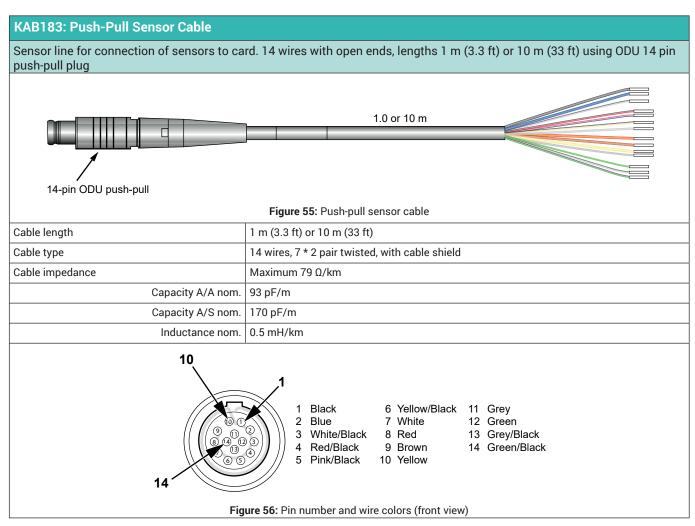
(1) Like The manufacturer declares on its sole responsibility that the product is in conformity with the essential requirements of the applicable UK legislation and that the relevant conformity assessment procedures have been fulfilled.

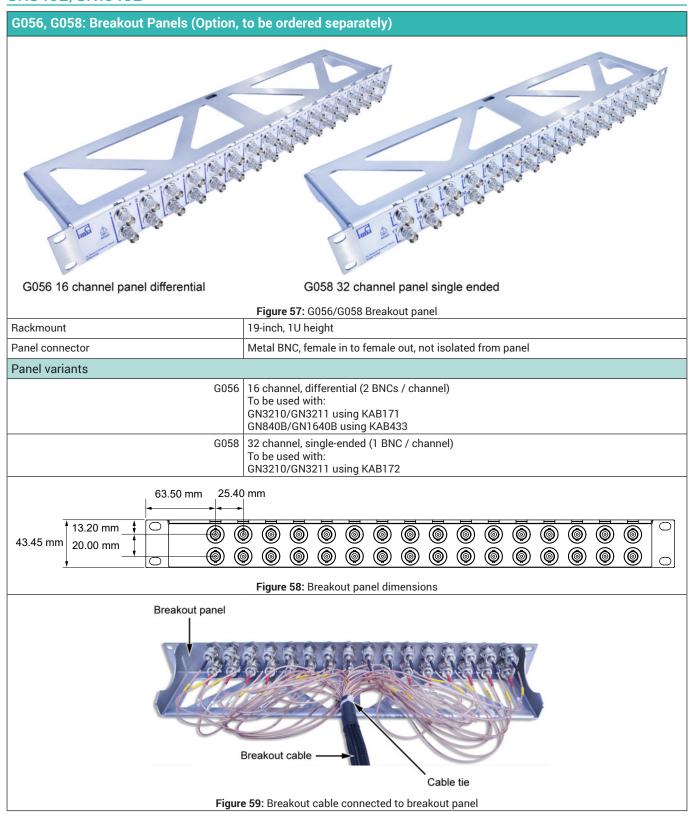
Manufacturer:

Hottinger Brüel & Kjaer GmbH Im Tiefen See 45 64293 Darmstadt Germany Importer:

Hottinger Bruel & Kjaer UK Ltd.
Technology Centre Advanced Manufacturing Park
Brunel Way Catcliffe
Rotherham
South Yorkshire
S60 5WG
United Kingdom







Ordering Informa	Ordering Information				
Article		Description	Order No.		
8 Channel, Universal/Sensor Isolated 500 kS/s		Universal input card, 8 channels; 500 kS/s, 24 bit, 2 GB RAM.	1-GN840B		
		Features:  Isolated  1 mV to ± 10 V input range  33 V RMS isolated balanced diff bridge input  ODU input connector for each channel  Strain gauge quarter/half/full bridges  wire configuration  Voltage excited sensors  IEPE sensors  Piezoelectric/charge sensors  to 20 mA output sensors  Pt10, Pt100, Pt500, Pt1000, Pt2000 (3/4 wire RTD)  Thermocouples types K, J, T, B, E, N, R, S, C  Supports real-time formula data base option (1-GEN-OP-RT-FDB)			
		Requirements: Tethered mainframes: GEN2tB, -3t, -4tB, -7tA, -7tB, -17tA, -17tB Mainframes with integrated PC: GEN3i, -3iA, -7i, -7iA, -7iB			
16 Channel, Universal/Sensor Isolated 500 kS/s		Universal input card, 16 channels, 2 slots width; 500 kS/s, 24 bit, 2 GB RAM.	1-GN1640B		
		Features:  Isolated  ± 1 mV to ± 10 V input range  33 V RMS isolated balanced diff bridge input  ODU input connector for each channel  Strain gauge quarter/half/full bridges  6 wire configuration  Voltage excited sensors  IEPE sensors  Piezoelectric/charge sensors  4 to 20 mA output sensors  Pt10, Pt100, Pt500, Pt1000, Pt2000 (3/4 wire RTD)  Thermocouples types K, J, T, B, E, N, R, S, C  Supports real-time formula data base option (1-GEN-OP-RT-FDB)			
		Requirements: Tethered mainframes: GEN2tB, -3t, -4tB, -7tA, -7tB, -17tA, -17tB Mainframes with integrated PC: GEN3i, -3iA, -7i, -7iA, -7iB.			

Option, to be ordered separately			
Article		Description	Order No.
GEN DAQ real-time formula database calculators	Consider Channel  Fix  Tager Dated to  13	Option to enable enhanced real-time calculators. Setup uses a user configurable formula database similar to the Perception formula database. All calculations are performed by the DSP of the acquisition card. Triggering possible on many of the results of the calculations. Calculated cycle based results can be real-time transferred to the GEN DAQ API, USB-to-CAN-FD or EtherCAT® option. EtherCAT® output supports true real-time 1 ms latency.	1-GEN-OP-RT-FDB

Cables and Connectors, to be ordered separately				
Article		Description	Order No.	
CON-P1007		Push-pull plug (ODU 14p) for sensor connection to card.	1-CON-P1007	
ODU to BNC breakout cable		Single-ended BNC voltage input to card coaxial cable including a female to female BNC adapter. Length 2 m (6.6 ft). Typical cable capacity 200 pF. Supports single-ended voltage, IEPE and charge measurements.	1-KAB433-2	
Cable 14 pin ODU to ODU		Cable to connect channel ODU connector to DIN rail breakout blocks. All 14 pins are connected. Cable length 3 m (9.9 ft). To be used with GN1640B and GN840B.	1-KAB2124-3	
ODU All wire breakout cable		Sensor line for connection of sensors to card Plug: ODU 14p push-pull. Cable: 14 wire with open ends, lengths 1 m (3.3 ft) or 10 m (33 ft)	1-KAB183-1 1-KAB183-10	
Piezoelectric sensor cable		Coaxial-cable for connection of a piezoelectric sensor to a piezoelectric amplifier.  Connectors 10 - 32 UNF and BNC Cable coaxial, lengths 1 m (3.3 ft), 2 m (6.6 ft) or 3 m (9.9 ft)	1-KAB176-1 1-KAB176-2 1-KAB176-3	
Coax cable, RG-58, 50 Ω impedance		Black coax cable RG-58. 1 shielded signal wire @ 0.14 mm². Impedance 50 Ω, 82 pF/m (25 pF/ft). Outside diameter 5 mm² (0.2").	Ordered from custom systems <sup>(1)</sup>	
Measuring cable 6 wires, PFA, 20 m		Shielded measurement cable AWG 32 (19 x 0.05 mm) 6-core cable, stranded wire sheath; Color: white; sheath material: PFA; Outside diameter: 1.9 mm; Wire insulation: PFA; Wire diameter: 0.45 mm, Resistance: 0.492 $\Omega/m$ ; Capacitance wire-wire: 43 pF/m Thermal stability: -200 °C to +200 °. For connection of strain gauge bridge circuits 20 m on reel.	1-CABP1/20	

<sup>(1)</sup> Contact custom systems at: <a href="mailto:customsystems@hbkworld.com">customsystems@hbkworld.com</a>
Request quote/information for special products for GEN series.

Accessories, to be ordered separately			
Article		Description	Order No.
32 channel single- ended breakout panel	To the state of th	32 ch single-ended 19-inch mountable 1 U (44.45 mm) height breakout panel; 32 BNC feed-through To be used with: GN3210/GN3211 using KAB171 GN840B/GN1640B using KAB433	1-G058
DIN rail breakout block push-in connector		DIN rail mountable breakout block. Converts ODU input connector to 12 pin spring/push-in connector.	1-G088
DIN rail thermocouple with cold juntion and TEDS		DIN rail mountable breakout block. Converts ODU input connector to universal mini thermocouple connector. Includes digital cold junction temperature measurement and TEDS ID (class 2).	1-G089
DIN rail BNC breakout		DIN rail mountable breakout block. Converts ODU input connector to dual BNC differential output.	1-G090
Soldering terminal LS2	00 00 00 00 00 00 00	Bronze soldering tag on polyimide carrier suitable for dynamic loads; Attachment to test object: Bonding can be used up to 180 °C (356 °F), briefly up to 260 °C (500 °F)	1-LS 2

# Hottinger Brüel & Kjaer GmbH

Im Tiefen See 45 · 64293 Darmstadt · Germany Tel. +49 6151 803-0 · Fax +49 6151 803-9100 www.hbkworld.com · info@hbkworld.com